

## General Description

Virtex<sup>®</sup>-6 CXT FPGAs provide designers needing power-optimized 3.75 Gb/s transceiver performance with an optimized ratio of built-in system-level blocks. These include 36 Kb block RAM/FIFOs, up to 15 Mb of block RAM, up to 768 DSP48E1 slices, enhanced mixed-mode clock management blocks, PCI Express<sup>®</sup> (GEN 1) compatible integrated blocks, a tri-mode Ethernet media access controller (MAC), up to 241K logic cells, and strong IP support. Using the third generation ASMBL<sup>™</sup> (Advanced Silicon Modular Block) column-based architecture, the Virtex-6 CXT family also contains SelectIO<sup>™</sup> technology with built-in digitally controlled impedance, ChipSync<sup>™</sup> source-synchronous interface blocks, enhanced mixed-mode clock management blocks, and advanced configuration options. Customers needing higher transceiver speeds, greater I/O performance, additional Ethernet MACs, or greater capacity should instead use the Virtex-6 LXT or SXT families. Built on a 40 nm state-of-the-art copper process technology, Virtex-6 CXT FPGAs are a programmable alternative to custom ASIC technology. Virtex-6 CXT FPGAs are the programmable silicon foundation for Targeted Design Platforms that deliver integrated software and hardware components to enable designers to focus on innovation as soon as their development cycle begins.

## Summary of Virtex-6 CXT FPGA Features

- Advanced, high-performance, FPGA Logic
  - Real 6-input look-up table (LUT) technology
  - Dual LUT5 (5-input LUT) option
  - LUT/dual flip-flop pair for applications requiring rich register mix
  - Improved routing efficiency
  - 64-bit (or 32 x 2-bit) distributed LUT RAM option
  - SRL32/dual SRL16 with registered outputs option
- Powerful mixed-mode clock managers (MMCM)
  - MMCM blocks provide zero-delay buffering, frequency synthesis, clock-phase shifting, input-jitter filtering, and phase-matched clock division
- 36-Kb block RAM/FIFOs
  - Dual-port RAM blocks
  - Programmable
    - Dual-port widths up to 36 bits
    - Simple dual-port widths up to 72 bits
  - Enhanced programmable FIFO logic
  - Built-in optional error-correction circuitry
  - Optionally use each block as two independent 18 Kb blocks
- High-performance parallel SelectIO technology
  - 1.2 to 2.5V I/O operation
  - Source-synchronous interfacing using ChipSync<sup>™</sup> technology
  - Digitally controlled impedance (DCI) active termination
  - Flexible fine-grained I/O banking
  - High-speed memory interface support with integrated write-leveling capability
- Advanced DSP48E1 slices
  - 25 x 18, two's complement multiplier/accumulator
  - Optional pipelining
  - New optional pre-adder to assist filtering applications
  - Optional bitwise logic functionality
  - Dedicated cascade connections
- Flexible configuration options
  - SPI and Parallel Flash interface
  - Multi-bitstream support with dedicated fallback reconfiguration logic
  - Automatic bus width detection
- Integrated interface blocks for PCI Express designs
  - Compliant to the PCI Express Base Specification 2.0
  - Gen1 Endpoint (2.5 Gb/s) support with GTX transceivers
  - x1, x2, x4, or x8 lane support per block
  - One virtual channel, eight traffic classes
- GTX transceivers: 150 Mb/s to 3.75 Gb/s
- Integrated 10/100/1000 Mb/s Ethernet MAC block
  - Supports 1000BASE-X PCS/PMA and SGMII using GTX transceivers
  - Supports MII, GMII, and RGMII using SelectIO technology resources
- 40 nm copper CMOS process technology
- 1.0V core voltage
- Two speed grades (-1 and -2)
- Two temperature grades (commercial and industrial)
- High signal-integrity flip-chip packaging available in standard or Pb-free package options
- Compatibility across sub-families: CXT, LXT, and SXT devices are footprint compatible in the same package

## Virtex-6 CXT FPGA Feature Summary

Table 1: Virtex-6 CXT FPGA Feature Summary by Device

| Device     | Logic Cells | Configurable Logic Blocks (CLBs) |                          | DSP48E1 Slices <sup>(2)</sup> | Block RAM Blocks     |       |          | MMCMs <sup>(4)</sup> | Interface Blocks for PCI Express | Ethernet MACs <sup>(5)</sup> | Maximum GTX Transceivers | Total I/O Banks <sup>(6)</sup> | Max User I/O <sup>(7)</sup> |
|------------|-------------|----------------------------------|--------------------------|-------------------------------|----------------------|-------|----------|----------------------|----------------------------------|------------------------------|--------------------------|--------------------------------|-----------------------------|
|            |             | Slices <sup>(1)</sup>            | Max Distributed RAM (Kb) |                               | 18 Kb <sup>(3)</sup> | 36 Kb | Max (Kb) |                      |                                  |                              |                          |                                |                             |
| XC6VCX75T  | 74,496      | 11,640                           | 1,045                    | 288                           | 312                  | 156   | 5,616    | 6                    | 1                                | 1                            | 12                       | 9                              | 360                         |
| XC6VCX130T | 128,000     | 20,000                           | 1,740                    | 480                           | 528                  | 264   | 9,504    | 10                   | 2                                | 1                            | 16                       | 15                             | 600                         |
| XC6VCX195T | 199,680     | 31,200                           | 3,040                    | 640                           | 688                  | 344   | 12,384   | 10                   | 2                                | 1                            | 16                       | 15                             | 600                         |
| XC6VCX240T | 241,152     | 37,680                           | 3,650                    | 768                           | 832                  | 416   | 14,976   | 12                   | 2                                | 1                            | 16                       | 18                             | 600                         |

### Notes:

- Each Virtex-6 CXT FPGA slice contains four LUTs and eight flip-flops, only some slices can use their LUTs as distributed RAM or SRLs.
- Each DSP48E1 slice contains a 25 x 18 multiplier, an adder, and an accumulator.
- Block RAMs are fundamentally 36 Kbits in size. Each block can also be used as two independent 18 Kb blocks.
- Each CMT contains two mixed-mode clock managers (MMCM).
- This table lists individual Ethernet MACs per device.
- Does not include configuration Bank 0.
- This number does not include GTX transceivers.

## Virtex-6 CXT FPGA Device-Package Combinations and Maximum I/Os

Virtex-6 CXT FPGA package combinations with the maximum available I/Os per package are shown in Table 2.

Table 2: Virtex-6 CXT FPGA Device-Package Combinations and Maximum Available I/Os

| Package    | FF484 FFG484 |     | FF784 FFG784 |     | FF1156 FFG1156 |     |
|------------|--------------|-----|--------------|-----|----------------|-----|
| Size (mm)  | 23 x 23      |     | 29 x 29      |     | 35 x 35        |     |
| Device     | GTs          | I/O | GTs          | I/O | GTs            | I/O |
| XC6VCX75T  | 8 GTXs       | 240 | 12 GTXs      | 360 |                |     |
| XC6VCX130T | 8 GTXs       | 240 | 12 GTXs      | 400 | 16 GTXs        | 600 |
| XC6VCX195T |              |     | 12 GTXs      | 400 | 16 GTXs        | 600 |
| XC6VCX240T |              |     | 12 GTXs      | 400 | 16 GTXs        | 600 |

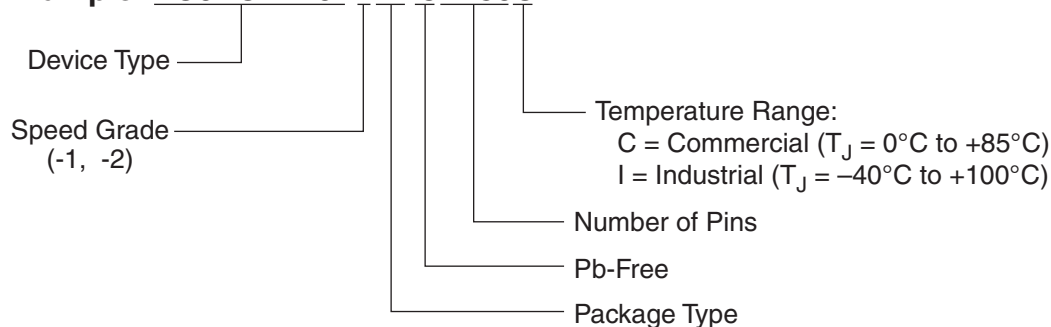
### Notes:

- Flip-chip packages are also available in Pb-Free versions (FFG).

## Virtex-6 CXT FPGA Ordering Information

The Virtex-6 CXT FPGA ordering information shown in Figure 1 applies to all packages including Pb-Free.

### Example: XC6VCX240T-1FFG1156C



DS153\_01\_062109

Figure 1: Virtex-6 CXT FPGA Ordering Information

## Virtex-6 CXT FPGA Documentation

In addition to the data sheet information found herein, complete and up-to-date documentation of the Virtex-6 family of FPGAs is available on the Xilinx website and available for download:

### ***Virtex-6 FPGA Configuration Guide*** ([UG360](#))

This all-encompassing configuration guide includes chapters on configuration interfaces (serial and parallel), multi-bitstream management, bitstream encryption, boundary-scan and JTAG configuration, and reconfiguration techniques.

### ***Virtex-6 FPGA SelectIO Resources User Guide*** ([UG361](#))

This guide describes the SelectIO™ resources available in all the Virtex-6 CXT devices.

### ***Virtex-6 FPGA Clocking Resources User Guide*** ([UG362](#))

This guide describes the clocking resources available in all the Virtex-6 CXT devices, including the MMCM and clock buffers.

### ***Virtex-6 FPGA Memory Resources User Guide*** ([UG363](#))

This guide describes the Virtex-6 CXT device block RAM and FIFO capabilities.

### ***Virtex-6 FPGA CLB User Guide*** ([UG364](#))

This guide describes the capabilities of the configurable logic blocks (CLB) available in all Virtex-6 CXT devices.

### ***Virtex-6 FPGA DSP48E1 Slice User Guide*** ([UG369](#))

This guide describes the architecture of the DSP48E1 slice in Virtex-6 CXT FPGAs and provides configuration examples.

### ***Virtex-6 FPGA GTX Transceivers User Guide*** ([UG366](#))

This guide describes the GTX transceivers available in all the Virtex-6 CXT FPGAs.

### ***Virtex-6 FPGA Tri-Mode Ethernet MAC User Guide*** ([UG368](#))

This guide describes the dedicated tri-mode Ethernet media access controller (TEMAC) available in all the Virtex-6 CXT FPGAs.

### ***Virtex-6 FPGA Data Sheet: DC and Switching Characteristics*** ([DS152](#))

Reference this data sheet when considering device migration to the Virtex-6 LXT and SXT families. It contains the DC and Switching Characteristic specifications specifically for the Virtex-6 LXT and SXT families.

### ***Virtex-6 FPGA Packaging and Pinout Specifications*** ([UG365](#))

These specifications includes the tables for device/package combinations and maximum I/Os, pin definitions, pinout tables, pinout diagrams, mechanical drawings, and thermal specifications of the Virtex-6 LXT and SXT families. Reference these specifications when considering device migration to the Virtex-6 LXT and SXT families.

## Configuration Bitstream Overview for CXT Devices

This section contains two tables similar to those in the *Virtex-6 FPGA Configuration Guide* only updated for the CXT family. The Virtex-6 CXT FPGA bitstream contains commands to the FPGA configuration logic as well as configuration data.

[Table 3](#) gives a typical bitstream length and [Table 4](#) gives the specific device ID codes for the Virtex-6 CXT devices.

**Table 3: Virtex-6 CXT FPGA Bitstream Length**

| Device     | Total Number of Configuration Bits |
|------------|------------------------------------|
| XC6VCX75T  | 26,239,328                         |
| XC6VCX130T | 43,719,776                         |
| XC6VCX195T | 61,552,736                         |
| XC6VCX240T | 73,859,552                         |

**Table 4: Virtex-6 CXT FPGA Device ID Codes**

| Device     | ID Code (Hex) |
|------------|---------------|
| XC6VCX75T  | 0x042C4093    |
| XC6VCX130T | 0x042CA093    |
| XC6VCX195T | 0x042CC093    |
| XC6VCX240T | 0x042D0093    |

## CLB Overview for CXT Devices

Table 5, updated specifically for the CXT family from a similar table in the *Virtex-6 FPGA CLB User Guide*, shows the available resources in all Virtex-6 CXT FPGA CLBs.

Table 5: Virtex-6 CXT FPGA Logic Resources Available in All CLBs

| Device     | Total Slices | SLICELs | SLICEMs | Number of 6-Input LUTs | Maximum Distributed RAM (Kb) | Shift Register (Kb) | Number of Flip-Flops |
|------------|--------------|---------|---------|------------------------|------------------------------|---------------------|----------------------|
| XC6VCX75T  | 11,640       | 7,460   | 4,180   | 46,560                 | 1045                         | 522.5               | 93,120               |
| XC6VCX130T | 20,000       | 13,040  | 6,960   | 80,000                 | 1740                         | 870                 | 160,000              |
| XC6VCX195T | 31,200       | 19,040  | 12,160  | 124,800                | 3140                         | 1570                | 249,600              |
| XC6VCX240T | 37,680       | 23,080  | 14,600  | 150,720                | 3770                         | 1885                | 301,440              |

## Regional Clock Management for CXT Devices

Table 6, updated from the *Virtex-6 FPGA Clocking Resources User Guide* specifically for the CXT family, shows the number of clock regions in all Virtex-6 CXT FPGA CLBs.

Table 6: Virtex-6 CXT FPGA Clock Regions

| Device     | Number of Clock Regions |
|------------|-------------------------|
| XC6VCX75T  | 6                       |
| XC6VCX130T | 10                      |
| XC6VCX195T | 10                      |
| XC6VCX240T | 12                      |

## CXT Packaging Specifications

Table 7, updated from the *Virtex-6 FPGA Packaging and Pinout Specifications* specifically for the CXT family, shows the number of GTX transceiver I/O channels. Table 8 shows the number of available I/Os and the number of differential I/O pairs for each Virtex-6 device/package combination.

Table 7: Number of Serial Transceivers (GTs) I/O Channels/Device

| I/O Channels | Device               |                       |                       |                       |
|--------------|----------------------|-----------------------|-----------------------|-----------------------|
|              | CX75T <sup>(1)</sup> | CX130T <sup>(2)</sup> | CX195T <sup>(3)</sup> | CX240T <sup>(4)</sup> |
| MGTRXP       | 8 or 12              | 8, 12, or 16          | 12 or 16              | 12 or 16              |
| MGTRXN       | 8 or 12              | 8, 12, or 16          | 12 or 16              | 12 or 16              |
| MGTTXP       | 8 or 12              | 8, 12, or 16          | 12 or 16              | 12 or 16              |
| MGTTXN       | 8 or 12              | 8, 12, or 16          | 12 or 16              | 12 or 16              |

### Notes:

1. The XC6VCX75T has 8 GTX I/O channels in the FF484/FFG484 package and 12 GTX I/O channels in the FF784/FFG784 package.
2. The XC6VCX130T has 8 GTX I/O channels in the FF484/FFG484 package, 12 GTX I/O channels in the FF784/FFG784 package, and 16 GTX I/O channels in the FF1156/FFG1156 package.
3. The XC6VCX195T has 12 GTX I/O channels in the FF784/FFG784 package and 16 GTX I/O channels in the FF1156/FFG1156 package.
4. The XC6VCX240T has 12 GTX I/O channels in the FF784/FFG784 package and 16 GTX I/O channels in the FF1156/FFG1156 package.

Table 8: Available I/O Pin/Device/Package Combinations

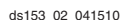
| Virtex-6 CXT Device | User I/O Pins          | Virtex-6 CXT FPGA Package |       |        |
|---------------------|------------------------|---------------------------|-------|--------|
|                     |                        | FF484                     | FF784 | FF1156 |
| XC6VCX75T           | Available User I/Os    | 240                       | 360   | –      |
|                     | Differential I/O Pairs | 120                       | 180   | –      |
| XC6VCX130T          | Available User I/Os    | 240                       | 400   | 600    |
|                     | Differential I/O Pairs | 120                       | 200   | 300    |
| XC6VCX195T          | Available User I/Os    | –                         | 400   | 600    |
|                     | Differential I/O Pairs | –                         | 200   | 300    |
| XC6VCX240T          | Available User I/Os    | –                         | 400   | 600    |
|                     | Differential I/O Pairs | –                         | 200   | 300    |

## GTX Transceivers in CXT Devices

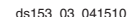
CXT devices have between 8 to 16 gigabit transceiver circuits. Each GTX transceiver is a combined transmitter and receiver capable of operating at a data rate between 480 Mb/s and 3.75 Gb/s. Lower data rates can be achieved using FPGA logic-based oversampling. The transmitter and receiver are independent circuits that use separate PLLs to multiply the reference frequency input by certain programmable numbers between 2 and 25, to become the bit-serial data clock. Each GTX transceiver has a large number of user-definable features and parameters. All of these can be defined during device configuration, and many can also be modified during operation.

Figure 2 and Figure 3 show the placement diagrams for the GTX transceivers in the FF484 package.

- CX75T: X0Y8, X0Y9, X0Y10, X0Y11
- CX130T: X0Y0, X0Y1, X0Y2, X0Y3, and X0Y12, X0Y13, X0Y14, X0Y15



**Figure 2: Placement Diagram for the FF484 Package  
(1 of 2)**



**Figure 3: Placement Diagram for the FF484 Package  
(2 of 2)**

## FF784 Package Placement Diagrams

Figure 4 through Figure 6 show the placement diagrams for the GTX transceivers in the FF784 package.

**Note:** Unbonded locations in the FF784 package are:

- CX130T: X0Y0, X0Y1, X0Y2, X0Y3
- CX195T: X0Y0, X0Y1, X0Y2, X0Y3
- CX240T: X0Y0, X0Y1, X0Y2, X0Y3

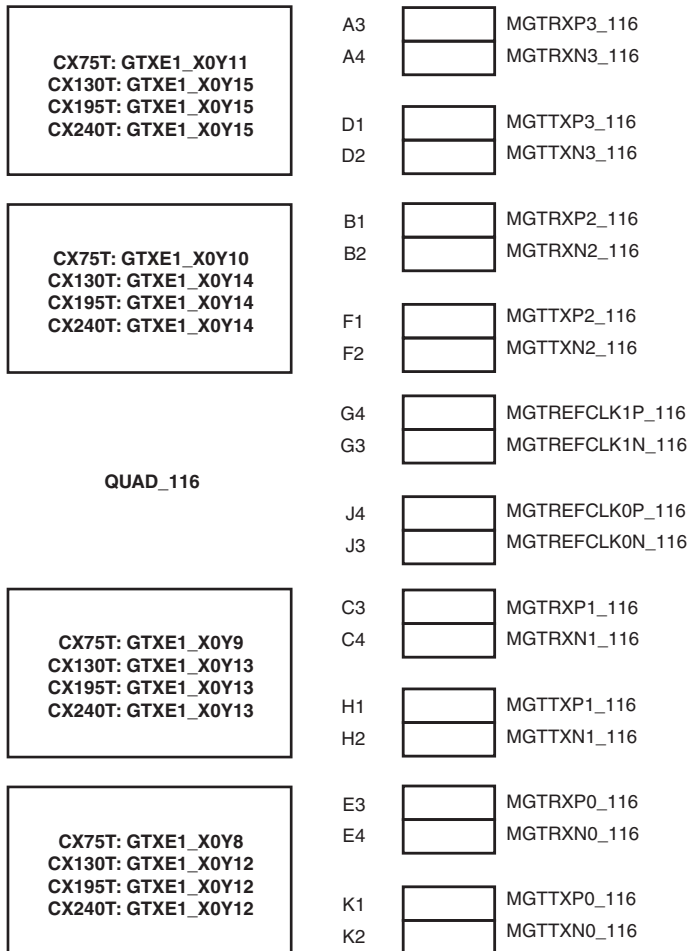


Figure 4: Placement Diagram for the FF784 Package  
(1 of 3)

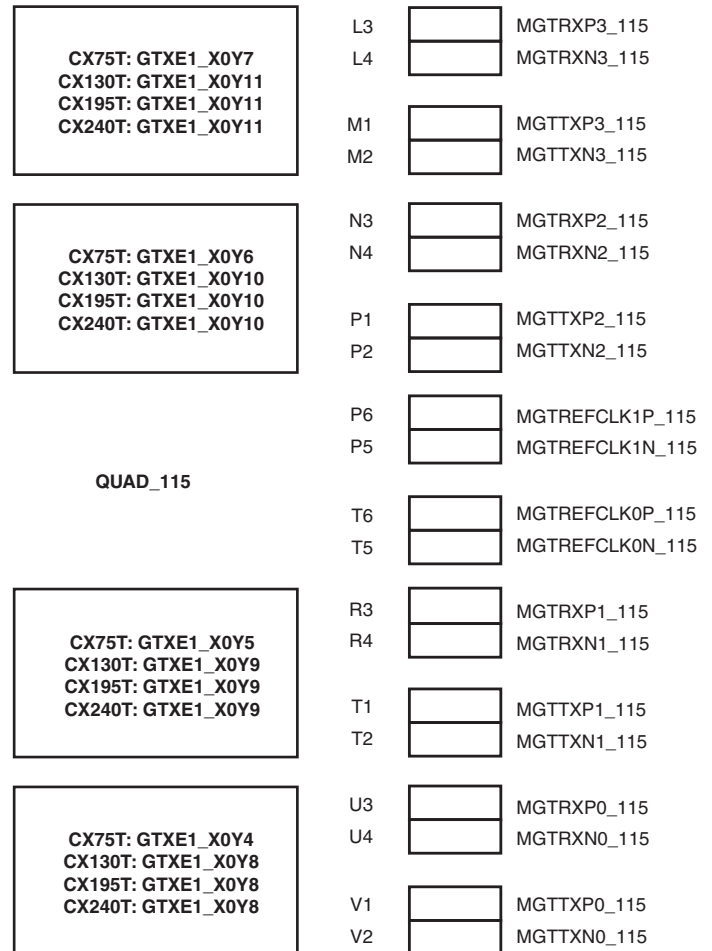


Figure 5: Placement Diagram for the FF784 Package  
(2 of 3)

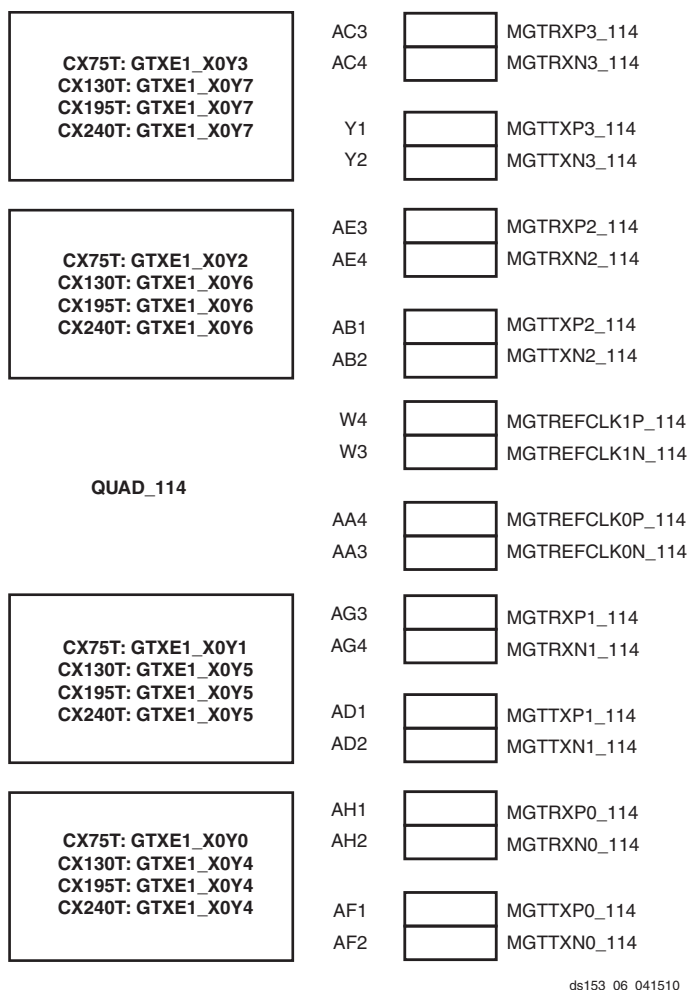


Figure 6: Placement Diagram for the FF784 Package  
(3 of 3)



## FF1156 Package Placement Diagrams

Figure 7 through Figure 10 show the placement diagrams for the GTX transceivers in the FF1156 package.

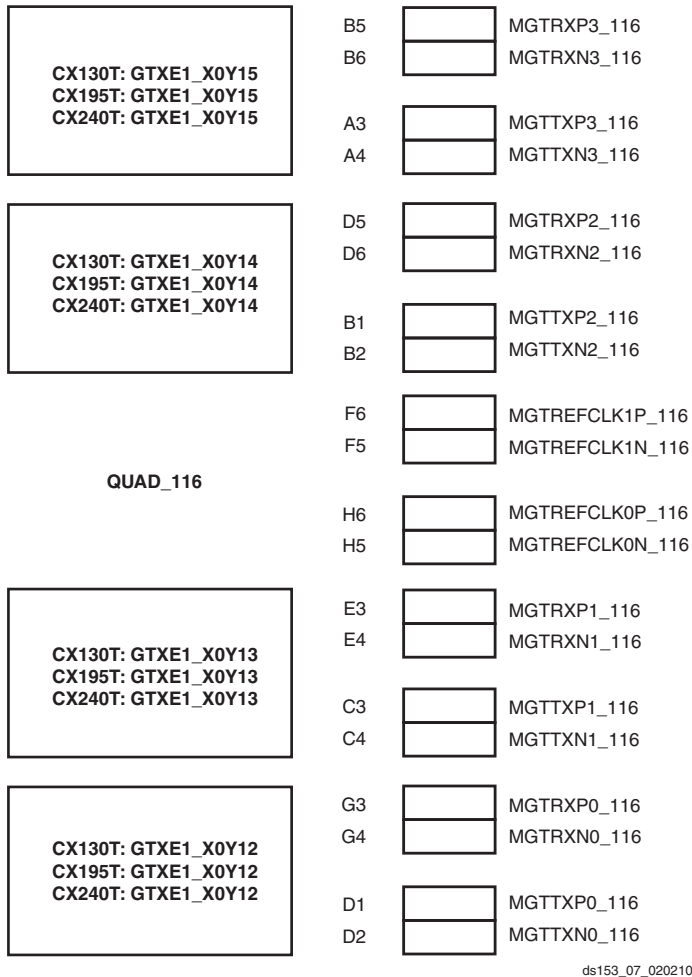


Figure 7: Placement Diagram for the FF1156 Package  
(1 of 4)

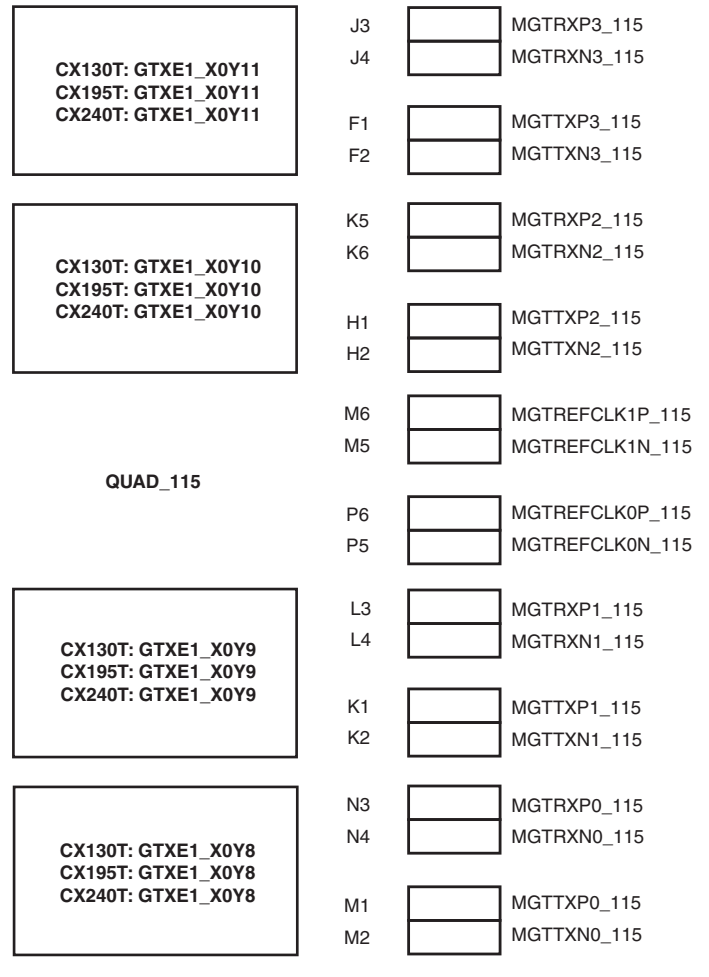


Figure 8: Placement Diagram for the FF1156 Package  
(2 of 4)

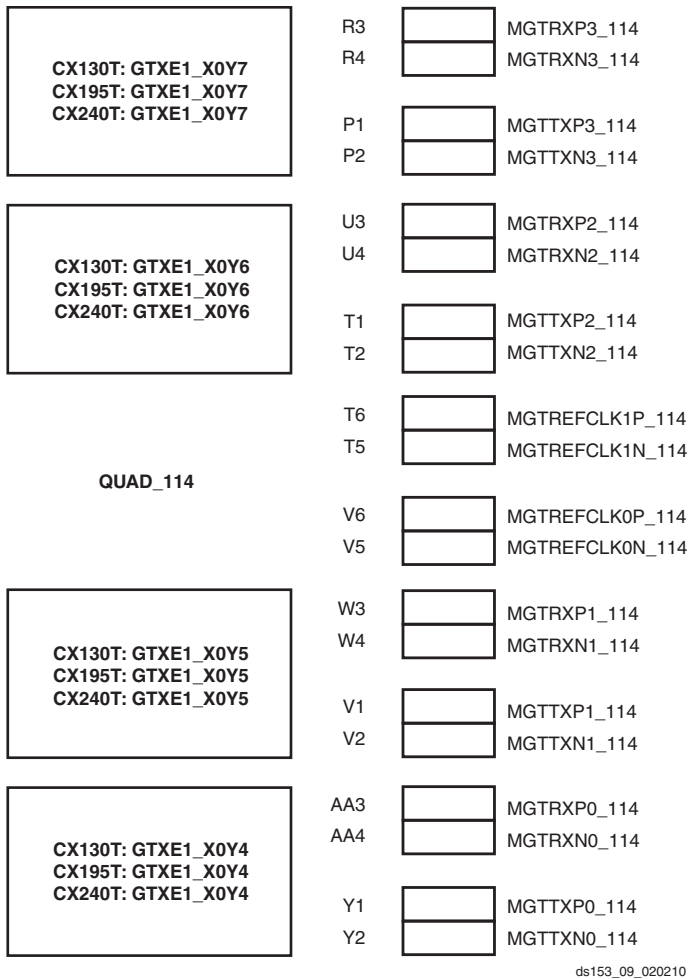


Figure 9: Placement Diagram for the FF1156 Package  
(3 of 4)

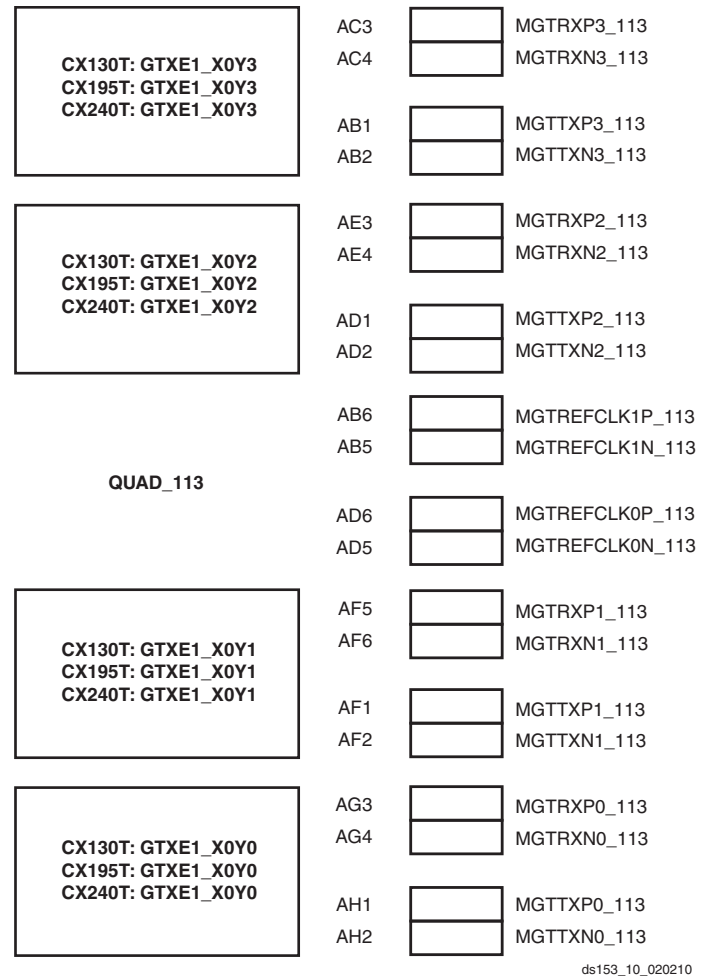


Figure 10: Placement Diagram for the FF1156 Package  
(4 of 4)

## Virtex-6 CXT FPGA Electrical Characteristics Introduction

Virtex-6 CXT FPGAs are available in -2 and -1 speed grades, with -2 having the highest performance. Virtex-6 CXT FPGA DC and AC characteristics are specified for both commercial and industrial grades. Except the operating temperature range or unless otherwise noted, all the DC and AC electrical parameters are the same for a particular speed grade (that is, the timing characteristics of a -1 speed grade industrial device are the same as for a -1 speed grade commercial device). However, only selected speed grades and/or devices might be available in the industrial range.

All supply voltage and junction temperature specifications are representative of worst-case conditions. The parameters included are common to popular designs and typical applications.

All specifications are subject to change without notice.

## Virtex-6 CXT FPGA DC Characteristics

Table 9: Absolute Maximum Ratings<sup>(1)</sup>

| Symbol                         | Description                                                                              |                                | Units |
|--------------------------------|------------------------------------------------------------------------------------------|--------------------------------|-------|
| V <sub>CCINT</sub>             | Internal supply voltage relative to GND                                                  | –0.5 to 1.1                    | V     |
| V <sub>CCAUX</sub>             | Auxiliary supply voltage relative to GND                                                 | –0.5 to 3.0                    | V     |
| V <sub>CCO</sub>               | Output drivers supply voltage relative to GND                                            | –0.5 to 3.0                    | V     |
| V <sub>BATT</sub>              | Key memory battery backup supply                                                         | –0.5 to 3.0                    | V     |
| V <sub>FS</sub>                | External voltage supply for eFUSE programming <sup>(2)</sup>                             | –0.5 to 3.0                    | V     |
| V <sub>REF</sub>               | Input reference voltage                                                                  | –0.5 to 3.0                    | V     |
| V <sub>IN</sub> <sup>(3)</sup> | 2.5V or below I/O input voltage relative to GND <sup>(4)</sup> (user and dedicated I/Os) | –0.5 to V <sub>CCO</sub> + 0.5 | V     |
| V <sub>TS</sub>                | Voltage applied to 3-state 2.5V or below output <sup>(4)</sup> (user and dedicated I/Os) | –0.5 to V <sub>CCO</sub> + 0.5 | V     |
| T <sub>STG</sub>               | Storage temperature (ambient)                                                            | –65 to 150                     | °C    |
| T <sub>SOL</sub>               | Maximum soldering temperature <sup>(5)</sup>                                             | +220                           | °C    |
| T <sub>j</sub>                 | Maximum junction temperature <sup>(5)</sup>                                              | +125                           | °C    |

### Notes:

- Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.
- When not programming eFUSE, connect V<sub>FS</sub> to GND.
- 2.5V I/O absolute maximum limit applied to DC and AC signals.
- For I/O operation, refer to the *Virtex-6 FPGA SelectIO Resources User Guide*.
- For soldering guidelines and thermal considerations, see *Virtex-6 FPGA Packaging and Pinout Specification*.

Table 10: Recommended Operating Conditions

| Symbol                | Description                                                                                          | Min        | Max             | Units |
|-----------------------|------------------------------------------------------------------------------------------------------|------------|-----------------|-------|
| $V_{CCINT}$           | Internal supply voltage relative to GND, $T_j = 0^\circ\text{C}$ to $+85^\circ\text{C}$              | 0.95       | 1.05            | V     |
|                       | Internal supply voltage relative to GND, $T_j = -40^\circ\text{C}$ to $+100^\circ\text{C}$           | 0.95       | 1.05            | V     |
| $V_{CCAUX}$           | Auxiliary supply voltage relative to GND, $T_j = 0^\circ\text{C}$ to $+85^\circ\text{C}$             | 2.375      | 2.625           | V     |
|                       | Auxiliary supply voltage relative to GND, $T_j = -40^\circ\text{C}$ to $+100^\circ\text{C}$          | 2.375      | 2.625           | V     |
| $V_{CCO}^{(1)(2)(3)}$ | Supply voltage relative to GND, $T_j = 0^\circ\text{C}$ to $+85^\circ\text{C}$                       | 1.14       | 2.625           | V     |
|                       | Supply voltage relative to GND, $T_j = -40^\circ\text{C}$ to $+100^\circ\text{C}$                    | 1.14       | 2.625           | V     |
| $V_{IN}$              | 2.5V supply voltage relative to GND, $T_j = 0^\circ\text{C}$ to $+85^\circ\text{C}$                  | GND – 0.20 | 2.625           | V     |
|                       | 2.5V supply voltage relative to GND, $T_j = -40^\circ\text{C}$ to $+100^\circ\text{C}$               | GND – 0.20 | 2.625           | V     |
|                       | 2.5V and below supply voltage relative to GND, $T_j = 0^\circ\text{C}$ to $+85^\circ\text{C}$        | GND – 0.20 | $V_{CCO} + 0.2$ | V     |
|                       | 2.5V and below supply voltage relative to GND, $T_j = -40^\circ\text{C}$ to $+100^\circ\text{C}$     | GND – 0.20 | $V_{CCO} + 0.2$ | V     |
| $I_{IN}^{(4)}$        | Maximum current through any pin in a powered or unpowered bank when forward biasing the clamp diode. | –          | 10              | mA    |
| $V_{BATT}^{(5)}$      | Battery voltage relative to GND, $T_j = 0^\circ\text{C}$ to $+85^\circ\text{C}$                      | 1.0        | 2.5             | V     |
|                       | Battery voltage relative to GND, $T_j = -40^\circ\text{C}$ to $+100^\circ\text{C}$                   | 1.0        | 2.5             | V     |
| $V_{FS}^{(6)}$        | External voltage supply for eFUSE programming                                                        | 2.375      | 2.625           | V     |

**Notes:**

1. Configuration data is retained even if  $V_{CCO}$  drops to 0V.
2. Includes  $V_{CCO}$  of 1.2V, 1.5V, 1.8V, and 2.5V.
3. The configuration supply voltage  $V_{CC\_CONFIG}$  is also known as  $V_{CCO\_0}$ .
4. A total of 100 mA per bank should not be exceeded.
5.  $V_{BATT}$  is required only when using bitstream encryption. If battery is not used, connect  $V_{BATT}$  to either ground or  $V_{CCAUX}$ .
6. When not programming eFUSE, connect  $V_{FS}$  to GND.
7. All voltages are relative to ground.

Table 11: DC Characteristics Over Recommended Operating Conditions<sup>(1)(2)</sup>

| Symbol         | Description                                                                       | Min  | Typ    | Max | Units         |
|----------------|-----------------------------------------------------------------------------------|------|--------|-----|---------------|
| $V_{DRINT}$    | Data retention $V_{CCINT}$ voltage (below which configuration data might be lost) | 0.75 | –      | –   | V             |
| $V_{DRI}$      | Data retention $V_{CCAUX}$ voltage (below which configuration data might be lost) | 2.0  | –      | –   | V             |
| $I_{REF}$      | $V_{REF}$ leakage current per pin                                                 | –    | –      | 10  | $\mu\text{A}$ |
| $I_L$          | Input or output leakage current per pin (sample-tested)                           | –    | –      | 10  | $\mu\text{A}$ |
| $C_{IN}^{(3)}$ | Die input capacitance at the pad                                                  | –    | –      | 8   | pF            |
| $I_{RPU}$      | Pad pull-up (when selected) @ $V_{IN} = 0\text{V}$ , $V_{CCO} = 2.5\text{V}$      | 20   | –      | 80  | $\mu\text{A}$ |
|                | Pad pull-up (when selected) @ $V_{IN} = 0\text{V}$ , $V_{CCO} = 1.8\text{V}$      | 8    | –      | 40  | $\mu\text{A}$ |
|                | Pad pull-up (when selected) @ $V_{IN} = 0\text{V}$ , $V_{CCO} = 1.5\text{V}$      | 5    | –      | 30  | $\mu\text{A}$ |
|                | Pad pull-up (when selected) @ $V_{IN} = 0\text{V}$ , $V_{CCO} = 1.2\text{V}$      | 1    | –      | 20  | $\mu\text{A}$ |
| $I_{RPD}$      | Pad pull-down (when selected) @ $V_{IN} = 2.5\text{V}$                            | 3    | –      | 80  | $\mu\text{A}$ |
| $I_{BATT}$     | Battery supply current                                                            | –    | –      | 150 | nA            |
| $n$            | Temperature diode ideality factor                                                 | –    | 1.0002 | –   | n             |
| $r$            | Series resistance                                                                 | –    | 5      | –   | $\Omega$      |

**Notes:**

1. Typical values are specified at nominal voltage,  $25^\circ\text{C}$ .
2. Maximum value specified for worst case process at  $25^\circ\text{C}$ .
3. This measurement represents the die capacitance at the pad, not including the package.

## Quiescent Supply Current: Important Note

Typical values for quiescent supply current are specified at nominal voltage, 85°C junction temperatures ( $T_j$ ). Xilinx recommends analyzing static power consumption at  $T_j = 85^\circ\text{C}$  because the majority of designs operate near the high end of the commercial temperature range. Quiescent supply current is specified by speed grade for Virtex-6 CXT devices. Use the XPOWER™ Estimator (XPE) spreadsheet tool (download at <http://www.xilinx.com/power>) to calculate static power consumption for conditions other than those specified in Table 12.

Table 12: Typical Quiescent Supply Current

| Symbol       | Description                          | Device     | Speed and Temperature Grade |            | Units |
|--------------|--------------------------------------|------------|-----------------------------|------------|-------|
|              |                                      |            | -2 (C & I)                  | -1 (C & I) |       |
| $I_{CCINTQ}$ | Quiescent $V_{CCINT}$ supply current | XC6VCX75T  | 927                         | 927        | mA    |
|              |                                      | XC6VCX130T | 1563                        | 1563       | mA    |
|              |                                      | XC6VCX195T | 2059                        | 2059       | mA    |
|              |                                      | XC6VCX240T | 2478                        | 2478       | mA    |
| $I_{CCOQ}$   | Quiescent $V_{CCO}$ supply current   | XC6VCX75T  | 1                           | 1          | mA    |
|              |                                      | XC6VCX130T | 1                           | 1          | mA    |
|              |                                      | XC6VCX195T | 1                           | 1          | mA    |
|              |                                      | XC6VCX240T | 2                           | 2          | mA    |
| $I_{CCAUXQ}$ | Quiescent $V_{CCAUX}$ supply current | XC6VCX75T  | 45                          | 45         | mA    |
|              |                                      | XC6VCX130T | 75                          | 75         | mA    |
|              |                                      | XC6VCX195T | 113                         | 113        | mA    |
|              |                                      | XC6VCX240T | 135                         | 135        | mA    |

### Notes:

1. Typical values are specified at nominal voltage, 85°C junction temperatures ( $T_j$ ). Industrial (I) grade devices have the same typical values as commercial (C) grade devices at 85°C, but higher values at 100°C. Use the XPE tool to calculate 100°C values.
2. Typical values are for blank configured devices with no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
3. If DCI or differential signaling is used, more accurate quiescent current estimates can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.

## Power-On Power Supply Requirements

Xilinx FPGAs require a certain amount of supply current during power-on to insure proper device initialization. The actual current consumed depends on the power-on ramp rate of the power supply.

Virtex-6 CXT devices require a power-on sequence of  $V_{CCINT}$ ,  $V_{CCAUX}$ , and  $V_{CCO}$ . If the requirement can not be met, then  $V_{CCAUX}$  must always be powered prior to  $V_{CCO}$ .  $V_{CCAUX}$  and  $V_{CCO}$  can be powered by the same supply, therefore, both  $V_{CCAUX}$  and  $V_{CCO}$  are permitted to ramp simultaneously. Similarly, for the power-down sequence,  $V_{CCO}$  must be powered down prior to  $V_{CCAUX}$  or if powered by the same supply,  $V_{CCAUX}$  and  $V_{CCO}$  power-down simultaneously.

Table 13 shows the minimum current, in addition to  $I_{CCOQ}$ , that are required by Virtex-6 CXT devices for proper power-on and configuration. If the current minimums shown in Table 12 and Table 13 are met, the device powers on after all three supplies have passed through their power-on reset threshold voltages. The FPGA must be configured after  $V_{CCINT}$  is applied.

Once initialized and configured, use the XPOWER tools to estimate current drain on these supplies.

Table 13: Power-On Current for Virtex-6 CXT Devices

| Device     | $I_{CCINTMIN}$               | $I_{CCAUXMIN}$     | $I_{CCOMIN}$                | Units |
|------------|------------------------------|--------------------|-----------------------------|-------|
|            | Typ <sup>(1)</sup>           | Typ <sup>(1)</sup> | Typ <sup>(1)</sup>          |       |
| XC6VCX75T  | See $I_{CCINTQ}$ in Table 12 | $I_{CCAUXQ} + 10$  | $I_{CCOQ} + 30$ mA per bank | mA    |
| XC6VCX130T | See $I_{CCINTQ}$ in Table 12 | $I_{CCAUXQ} + 10$  | $I_{CCOQ} + 30$ mA per bank | mA    |
| XC6VCX195T | See $I_{CCINTQ}$ in Table 12 | $I_{CCAUXQ} + 40$  | $I_{CCOQ} + 30$ mA per bank | mA    |
| XC6VCX240T | See $I_{CCINTQ}$ in Table 12 | $I_{CCAUXQ} + 40$  | $I_{CCOQ} + 30$ mA per bank | mA    |

### Notes:

1. Typical values are specified at nominal voltage, 25°C.
2. Use the XPOWER™ Estimator (XPE) spreadsheet tool (download at <http://www.xilinx.com/power>) to calculate maximum power-on currents.

Table 14: Power Supply Ramp Time

| Symbol      | Description                                   | Ramp Time    | Units |
|-------------|-----------------------------------------------|--------------|-------|
| $V_{CCINT}$ | Internal supply voltage relative to GND       | 0.20 to 50.0 | ms    |
| $V_{CCO}$   | Output drivers supply voltage relative to GND | 0.20 to 50.0 | ms    |
| $V_{CCAUX}$ | Auxiliary supply voltage relative to GND      | 0.20 to 50.0 | ms    |

## SelectIO™ DC Input and Output Levels

Values for  $V_{IL}$  and  $V_{IH}$  are recommended input voltages. Values for  $I_{OL}$  and  $I_{OH}$  are guaranteed over the recommended operating conditions at the  $V_{OL}$  and  $V_{OH}$  test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at a minimum  $V_{CCO}$  with the respective  $V_{OL}$  and  $V_{OH}$  voltage levels shown. Other standards are sample tested.

Table 15: SelectIO DC Input and Output Levels

| I/O Standard                | $V_{IL}$ |                          | $V_{IH}$                 |                 | $V_{OL}$         | $V_{OH}$         | $I_{OL}$ | $I_{OH}$ |
|-----------------------------|----------|--------------------------|--------------------------|-----------------|------------------|------------------|----------|----------|
|                             | V, Min   | V, Max                   | V, Min                   | V, Max          | V, Max           | V, Min           | mA       | mA       |
| LVC MOS25,<br>LVDCI25       | -0.3     | 0.7                      | 1.7                      | $V_{CCO} + 0.3$ | 0.4              | $V_{CCO} - 0.4$  | Note(3)  | Note(3)  |
| LVC MOS18,<br>LVDCI18       | -0.3     | 35% $V_{CCO}$            | 65% $V_{CCO}$            | $V_{CCO} + 0.3$ | 0.45             | $V_{CCO} - 0.45$ | Note(4)  | Note(4)  |
| LVC MOS15,<br>LVDCI15       | -0.3     | 35% $V_{CCO}$            | 65% $V_{CCO}$            | $V_{CCO} + 0.3$ | 25% $V_{CCO}$    | 75% $V_{CCO}$    | Note(4)  | Note(4)  |
| LVC MOS12                   | -0.3     | 35% $V_{CCO}$            | 65% $V_{CCO}$            | $V_{CCO} + 0.3$ | 25% $V_{CCO}$    | 75% $V_{CCO}$    | Note(5)  | Note(5)  |
| HSTL I <sub>12</sub>        | -0.3     | $V_{REF} - 0.1$          | $V_{REF} + 0.1$          | $V_{CCO} + 0.3$ | 25% $V_{CCO}$    | 75% $V_{CCO}$    | 6.3      | 6.3      |
| HSTL I <sup>(2)</sup>       | -0.3     | $V_{REF} - 0.1$          | $V_{REF} + 0.1$          | $V_{CCO} + 0.3$ | 0.4              | $V_{CCO} - 0.4$  | 8        | -8       |
| HSTL II <sup>(2)</sup>      | -0.3     | $V_{REF} - 0.1$          | $V_{REF} + 0.1$          | $V_{CCO} + 0.3$ | 0.4              | $V_{CCO} - 0.4$  | 16       | -16      |
| HSTL III <sup>(2)</sup>     | -0.3     | $V_{REF} - 0.1$          | $V_{REF} + 0.1$          | $V_{CCO} + 0.3$ | 0.4              | $V_{CCO} - 0.4$  | 24       | -8       |
| DIFF HSTL I <sup>(2)</sup>  | -0.3     | 50% $V_{CCO} - 0.1$      | 50% $V_{CCO} + 0.1$      | $V_{CCO} + 0.3$ | —                | —                | —        | —        |
| DIFF HSTL II <sup>(2)</sup> | -0.3     | 50% $V_{CCO} - 0.1$      | 50% $V_{CCO} + 0.1$      | $V_{CCO} + 0.3$ | —                | —                | —        | —        |
| SSTL2 I                     | -0.3     | $V_{REF} - 0.15$         | $V_{REF} + 0.15$         | $V_{CCO} + 0.3$ | $V_{TT} - 0.61$  | $V_{TT} + 0.61$  | 8.1      | -8.1     |
| SSTL2 II                    | -0.3     | $V_{REF} - 0.15$         | $V_{REF} + 0.15$         | $V_{CCO} + 0.3$ | $V_{TT} - 0.81$  | $V_{TT} + 0.81$  | 16.2     | -16.2    |
| DIFF SSTL2 I                | -0.3     | 50%<br>$V_{CCO} - 0.15$  | 50%<br>$V_{CCO} + 0.15$  | $V_{CCO} + 0.3$ | —                | —                | —        | —        |
| DIFF SSTL2 II               | -0.3     | 50%<br>$V_{CCO} - 0.15$  | 50%<br>$V_{CCO} + 0.15$  | $V_{CCO} + 0.3$ | —                | —                | —        | —        |
| SSTL18 I                    | -0.3     | $V_{REF} - 0.125$        | $V_{REF} + 0.125$        | $V_{CCO} + 0.3$ | $V_{TT} - 0.47$  | $V_{TT} + 0.47$  | 6.7      | -6.7     |
| SSTL18 II                   | -0.3     | $V_{REF} - 0.125$        | $V_{REF} + 0.125$        | $V_{CCO} + 0.3$ | $V_{TT} - 0.60$  | $V_{TT} + 0.60$  | 13.4     | -13.4    |
| DIFF SSTL18 I               | -0.3     | 50%<br>$V_{CCO} - 0.125$ | 50%<br>$V_{CCO} + 0.125$ | $V_{CCO} + 0.3$ | —                | —                | —        | —        |
| DIFF SSTL18 II              | -0.3     | 50%<br>$V_{CCO} - 0.125$ | 50%<br>$V_{CCO} + 0.125$ | $V_{CCO} + 0.3$ | —                | —                | —        | —        |
| SSTL15                      | -0.3     | $V_{REF} - 0.1$          | $V_{REF} + 0.1$          | $V_{CCO} + 0.3$ | $V_{TT} - 0.175$ | $V_{TT} + 0.175$ | 14.3     | 14.3     |

### Notes:

1. Tested according to relevant specifications.
2. Applies to both 1.5V and 1.8V HSTL.
3. Using drive strengths of 2, 4, 6, 8, 12, 16, or 24 mA.
4. Using drive strengths of 2, 4, 6, 8, 12, or 16 mA.
5. Supported drive strengths of 2, 4, 6, or 8 mA.
6. For detailed interface specific DC voltage levels, see the *Virtex-6 FPGA SelectIO Resources User Guide*.

## HT DC Specifications (HT\_25)

Table 16: HT DC Specifications

| Symbol           | DC Parameter                  | Conditions                                              | Min  | Typ | Max  | Units |
|------------------|-------------------------------|---------------------------------------------------------|------|-----|------|-------|
| $V_{CCO}$        | Supply Voltage                |                                                         | 2.38 | 2.5 | 2.63 | V     |
| $V_{OD}$         | Differential Output Voltage   | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 480  | 600 | 885  | mV    |
| $\Delta V_{OD}$  | Change in $V_{OD}$ Magnitude  |                                                         | -15  | -   | 15   | mV    |
| $V_{OCM}$        | Output Common Mode Voltage    | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 480  | 600 | 885  | mV    |
| $\Delta V_{OCM}$ | Change in $V_{OCM}$ Magnitude |                                                         | -15  | -   | 15   | mV    |
| $V_{ID}$         | Input Differential Voltage    |                                                         | 200  | 600 | 1000 | mV    |
| $\Delta V_{ID}$  | Change in $V_{ID}$ Magnitude  |                                                         | -15  | -   | 15   | mV    |
| $V_{ICM}$        | Input Common Mode Voltage     |                                                         | 440  | 600 | 780  | mV    |
| $\Delta V_{ICM}$ | Change in $V_{ICM}$ Magnitude |                                                         | -15  | -   | 15   | mV    |

## LVDS DC Specifications (LVDS\_25)

Table 17: LVDS DC Specifications

| Symbol      | DC Parameter                                                                                                | Conditions                                              | Min   | Typ   | Max   | Units |
|-------------|-------------------------------------------------------------------------------------------------------------|---------------------------------------------------------|-------|-------|-------|-------|
| $V_{CCO}$   | Supply Voltage                                                                                              |                                                         | 2.38  | 2.5   | 2.63  | V     |
| $V_{OH}$    | Output High Voltage for Q and $\overline{Q}$                                                                | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | -     | -     | 1.675 | V     |
| $V_{OL}$    | Output Low Voltage for Q and $\overline{Q}$                                                                 | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 0.825 | -     | -     | V     |
| $V_{ODIFF}$ | Differential Output Voltage (Q - $\overline{Q}$ ),<br>Q = High ( $\overline{Q}$ - Q), $\overline{Q}$ = High | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 247   | 350   | 600   | mV    |
| $V_{OCM}$   | Output Common-Mode Voltage                                                                                  | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 1.075 | 1.250 | 1.425 | V     |
| $V_{IDIFF}$ | Differential Input Voltage (Q - $\overline{Q}$ ),<br>Q = High ( $\overline{Q}$ - Q), $\overline{Q}$ = High  |                                                         | 100   | 350   | 600   | mV    |
| $V_{ICM}$   | Input Common-Mode Voltage                                                                                   |                                                         | 0.3   | 1.2   | 2.2   | V     |

## Extended LVDS DC Specifications (LVDSEXT\_25)

Table 18: Extended LVDS DC Specifications

| Symbol      | DC Parameter                                                                                                | Conditions                                              | Min   | Typ   | Max   | Units |
|-------------|-------------------------------------------------------------------------------------------------------------|---------------------------------------------------------|-------|-------|-------|-------|
| $V_{CCO}$   | Supply Voltage                                                                                              |                                                         | 2.38  | 2.5   | 2.63  | V     |
| $V_{OH}$    | Output High Voltage for Q and $\overline{Q}$                                                                | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | -     | -     | 1.785 | V     |
| $V_{OL}$    | Output Low Voltage for Q and $\overline{Q}$                                                                 | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 0.715 | -     | -     | V     |
| $V_{ODIFF}$ | Differential Output Voltage (Q - $\overline{Q}$ ),<br>Q = High ( $\overline{Q}$ - Q), $\overline{Q}$ = High | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 350   | -     | 840   | mV    |
| $V_{OCM}$   | Output Common-Mode Voltage                                                                                  | $R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals | 1.075 | 1.250 | 1.425 | V     |
| $V_{IDIFF}$ | Differential Input Voltage (Q - $\overline{Q}$ ),<br>Q = High ( $\overline{Q}$ - Q), $\overline{Q}$ = High  | Common-mode input voltage = 1.25V                       | 100   | -     | 1000  | mV    |
| $V_{ICM}$   | Input Common-Mode Voltage                                                                                   | Differential input voltage = $\pm 350$ mV               | 0.3   | 1.2   | 2.2   | V     |



## LVPECL DC Specifications (LVPECL\_25)

These values are valid when driving a 100Ω differential load only, i.e., a 100Ω resistor between the two receiver pins. The  $V_{OH}$  levels are 200 mV below standard LVPECL levels and are compatible with devices tolerant of lower common-mode ranges. Table 19 summarizes the DC output specifications of LVPECL. For more information on using LVPECL, see the *Virtex-6 FPGA SelectIO Resources User Guide*.

Table 19: LVPECL DC Specifications

| Symbol      | DC Parameter                                 | Min              | Typ   | Max             | Units |
|-------------|----------------------------------------------|------------------|-------|-----------------|-------|
| $V_{OH}$    | Output High Voltage                          | $V_{CC} - 1.025$ | 1.545 | $V_{CC} - 0.88$ | V     |
| $V_{OL}$    | Output Low Voltage                           | $V_{CC} - 1.81$  | 0.795 | $V_{CC} - 1.62$ | V     |
| $V_{ICM}$   | Input Common-Mode Voltage                    | 0.6              | —     | 2.2             | V     |
| $V_{IDIFF}$ | Differential Input Voltage <sup>(1)(2)</sup> | 0.100            | —     | 1.5             | V     |

### Notes:

1. Recommended input maximum voltage not to exceed  $V_{CCAUX} + 0.2V$ .
2. Recommended input minimum voltage not to go below  $-0.5V$ .

## eFUSE Read Endurance

Table 20 lists the maximum number of read cycle operations expected. For more information, see the *Virtex-6 FPGA Configuration User Guide*.

Table 20: eFUSE Read Endurance

| Symbol     | Description                                                                                                 | Speed Grade |    |    |     | Units       |
|------------|-------------------------------------------------------------------------------------------------------------|-------------|----|----|-----|-------------|
|            |                                                                                                             | -3          | -2 | -1 | -1L |             |
| DNA_CYCLES | Number of DNA_PORT READ operations or JTAG ISC_DNA read command operations. Unaffected by SHIFT operations. | 30,000,000  |    |    |     | Read Cycles |
| AES_CYCLES | Number of JTAG FUSE_KEY or FUSE_CNTL read command operations. Unaffected by SHIFT operations.               | 30,000,000  |    |    |     | Read Cycles |

## GTX Transceiver Specifications

### GTX Transceiver DC Characteristics

Table 21: Absolute Maximum Ratings for GTX Transceivers<sup>(1)</sup>

| Symbol         | Description                                                                                     | Min  | Max  | Units |
|----------------|-------------------------------------------------------------------------------------------------|------|------|-------|
| MGTA VCC       | Analog supply voltage for the GTX transmitter and receiver circuits relative to GND             | -0.5 | 1.1  | V     |
| MGTA VTT       | Analog supply voltage for the GTX transmitter and receiver termination circuits relative to GND | -0.5 | 1.32 | V     |
| MGTA VTTRCAL   | Analog supply voltage for the resistor calibration circuit of the GTX transceiver column        | -0.5 | 1.32 | V     |
| $V_{IN}$       | Receiver (RXP/RXN) and Transmitter (TXP/TXN) absolute input voltage                             | -0.5 | 1.32 | V     |
| $V_{MGTRFCLK}$ | Reference clock absolute input voltage                                                          | -0.5 | 1.32 | V     |

### Notes:

1. Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.

Table 22: Recommended Operating Conditions for GTX Transceivers<sup>(1)(2)</sup>

| Symbol      | Description                                                                                     | Min  | Typ | Max  | Units |
|-------------|-------------------------------------------------------------------------------------------------|------|-----|------|-------|
| MGTAVCC     | Analog supply voltage for the GTX transmitter and receiver circuits relative to GND             | 0.95 | 1.0 | 1.06 | V     |
| MGTAVTT     | Analog supply voltage for the GTX transmitter and receiver termination circuits relative to GND | 1.14 | 1.2 | 1.26 | V     |
| MGTAVTTRCAL | Analog supply voltage for the resistor calibration circuit of the GTX transceiver column        | 1.14 | 1.2 | 1.26 | V     |

**Notes:**

- Each voltage listed requires the filter circuit described in *Virtex-6 FPGA GTX Transceivers User Guide*.
- Voltages are specified for the temperature range of  $T_j = -40^{\circ}\text{C}$  to  $+100^{\circ}\text{C}$ .

Table 23: GTX Transceiver Supply Current (per Lane)<sup>(1)(2)</sup>

| Symbol               | Description                                                       | Typ                  | Max    | Units |
|----------------------|-------------------------------------------------------------------|----------------------|--------|-------|
| I <sub>MGTAVTT</sub> | MGTAVTT supply current for one GTX transceiver                    | 55.9                 | Note 2 | mA    |
| I <sub>MGTAVCC</sub> | MGTAVCC supply current for one GTX transceiver                    | 56.1                 |        | mA    |
| MGTR <sub>REF</sub>  | Precision reference resistor for internal calibration termination | 100.0 ± 1% tolerance |        | Ω     |

**Notes:**

- Typical values are specified at nominal voltage, 25°C, with a 3.125 Gb/s line rate.
- Values for currents other than the values specified in this table can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.

Table 24: GTX Transceiver Quiescent Supply Current (per Lane)<sup>(1)(2)(3)</sup>

| Symbol                | Description                                              | Typ <sup>(4)</sup> | Max    | Units |
|-----------------------|----------------------------------------------------------|--------------------|--------|-------|
| $I_{\text{MGTAVTTQ}}$ | Quiescent MGTAVTT supply current for one GTX transceiver | 0.9                | Note 2 | mA    |
| $I_{\text{MGTAVCCQ}}$ | Quiescent MGTAVCC supply current for one GTX transceiver | 3.5                |        | mA    |

**Notes:**

- Device powered and unconfigured.
- Currents for conditions other than values specified in this table can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.
- GTX transceiver quiescent supply current for an entire device can be calculated by multiplying the values in this table by the number of available GTX transceivers.
- Typical values are specified at nominal voltage, 25°C.

## GTX Transceiver DC Input and Output Levels

Table 25 summarizes the DC output specifications of the GTX transceivers in Virtex-6 CXT FPGAs. Consult the *Virtex-6 FPGA GTX Transceivers User Guide* for further details.

Table 25: GTX Transceiver DC Specifications

| Symbol               | DC Parameter                                              | Conditions                                         | Min                                          | Typ                     | Max                 | Units |
|----------------------|-----------------------------------------------------------|----------------------------------------------------|----------------------------------------------|-------------------------|---------------------|-------|
| DV <sub>PPIN</sub>   | Differential peak-to-peak input voltage                   | External AC coupled                                | 125                                          | –                       | 2000                | mV    |
| V <sub>IN</sub>      | Absolute input voltage                                    | DC coupled<br>MGTA <sub>VTT</sub> = 1.2V           | –400                                         | –                       | MGTA <sub>VTT</sub> | mV    |
| V <sub>CMIN</sub>    | Common mode input voltage                                 | DC coupled<br>MGTA <sub>VTT</sub> = 1.2V           | –                                            | 2/3 MGTA <sub>VTT</sub> | –                   | mV    |
| DV <sub>PPOUT</sub>  | Differential peak-to-peak output voltage <sup>(1)</sup>   | Transmitter output swing is set to maximum setting | –                                            | –                       | 1000                | mV    |
| V <sub>CMOUTDC</sub> | DC common mode output voltage                             | Equation based                                     | MGTA <sub>VTT</sub> – DV <sub>PPOUT</sub> /4 |                         |                     | mV    |
| R <sub>IN</sub>      | Differential input resistance                             |                                                    | 80                                           | 100                     | 130                 | Ω     |
| R <sub>OUT</sub>     | Differential output resistance                            |                                                    | 80                                           | 100                     | 120                 | Ω     |
| T <sub>OSKEW</sub>   | Transmitter output pair (TXP and TXN) intra-pair skew     |                                                    | –                                            | 2                       | 8                   | ps    |
| C <sub>EXT</sub>     | Recommended external AC coupling capacitor <sup>(2)</sup> |                                                    | –                                            | 100                     | –                   | nF    |

### Notes:

1. The output swing and preemphasis levels are programmable using the attributes discussed in *Virtex-6 FPGA GTX Transceivers User Guide* and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

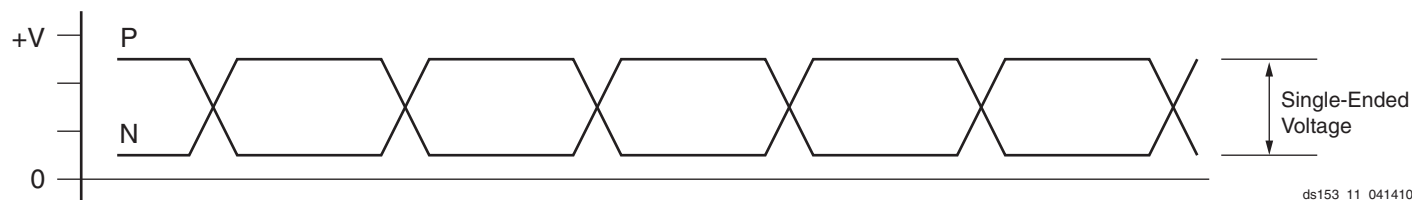


Figure 11: Single-Ended Peak-to-Peak Voltage

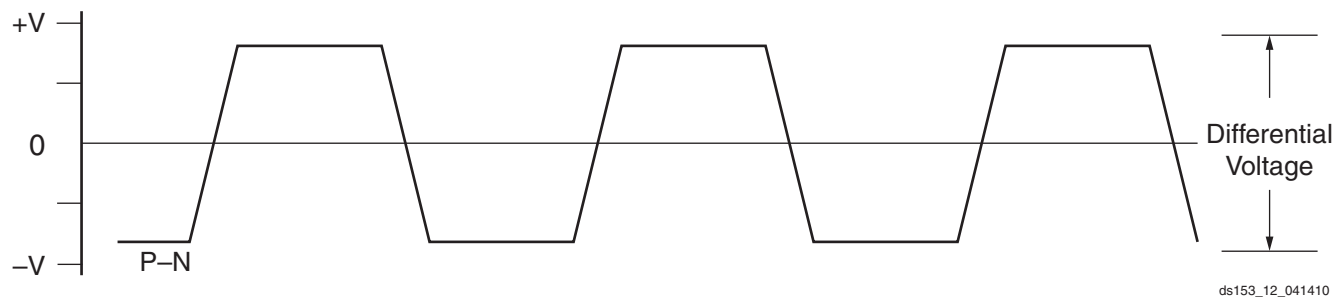


Figure 12: Differential Peak-to-Peak Voltage

Table 26 summarizes the DC specifications of the clock input of the GTX transceiver. Consult the *Virtex-6 FPGA GTX Transceivers User Guide* for further details.

Table 26: GTX Transceiver Clock DC Input Level Specification

| Symbol      | DC Parameter                            | Conditions | Min | Typ | Max  | Units    |
|-------------|-----------------------------------------|------------|-----|-----|------|----------|
| $V_{IDIFF}$ | Differential peak-to-peak input voltage |            | 210 | 800 | 2000 | mV       |
| $R_{IN}$    | Differential input resistance           |            | 90  | 100 | 130  | $\Omega$ |
| $C_{EXT}$   | Required external AC coupling capacitor |            | –   | 100 | –    | nF       |

## GTX Transceiver Switching Characteristics

Consult *Virtex-6 FPGA GTX Transceivers User Guide* for further information.

Table 27: GTX Transceiver Performance

| Symbol        | Description                       | Speed Grade |      | Units |
|---------------|-----------------------------------|-------------|------|-------|
|               |                                   | -2          | -1   |       |
| $F_{GTXMAX}$  | Maximum GTX transceiver data rate | 3.75        | 3.75 | Gb/s  |
| $F_{GPLLMAX}$ | Maximum PLL frequency             | 2.5         | 2.5  | GHz   |
| $F_{GPLLMIN}$ | Minimum PLL frequency             | 1.2         | 1.2  | GHz   |

Table 28: GTX Transceiver Dynamic Reconfiguration Port (DRP) Switching Characteristics

| Symbol          | Description                 | Speed Grade |     | Units |
|-----------------|-----------------------------|-------------|-----|-------|
|                 |                             | -2          | -1  |       |
| $F_{GTXDRPCLK}$ | GTXDRPCLK maximum frequency | 100         | 100 | MHz   |

Table 29: GTX Transceiver Reference Clock Switching Characteristics

| Symbol      | Description                               | Conditions                                               | All Speed Grades |     |     | Units   |
|-------------|-------------------------------------------|----------------------------------------------------------|------------------|-----|-----|---------|
|             |                                           |                                                          | Min              | Typ | Max |         |
| $F_{GCLK}$  | Reference clock frequency range           |                                                          | 67.5             | –   | 375 | MHz     |
| $T_{RCLK}$  | Reference clock rise time                 | 20% – 80%                                                | –                | 200 | –   | ps      |
| $T_{FCLK}$  | Reference clock fall time                 | 80% – 20%                                                | –                | 200 | –   | ps      |
| $T_{DCREF}$ | Reference clock duty cycle                | Transceiver PLL only                                     | 45               | 50  | 55  | %       |
| $T_{LOCK}$  | Clock recovery frequency acquisition time | Initial PLL lock                                         | –                | –   | 1   | ms      |
| $T_{PHASE}$ | Clock recovery phase acquisition time     | Lock to data after PLL has locked to the reference clock | –                | –   | 200 | $\mu$ s |

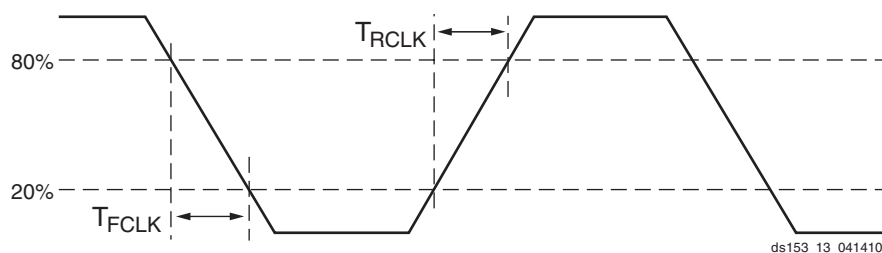


Figure 13: Reference Clock Timing Parameters

Table 30: GTX Transceiver User Clock Switching Characteristics<sup>(1)</sup>

| Symbol             | Description                 | Conditions                | Speed Grade |        | Units |
|--------------------|-----------------------------|---------------------------|-------------|--------|-------|
|                    |                             |                           | -2          | -1     |       |
| F <sub>TXOUT</sub> | TXOUTCLK maximum frequency  | Internal 20-bit data path | 187.5       | 187.5  | MHz   |
|                    |                             | Internal 16-bit data path | 234.38      | 234.38 | MHz   |
| F <sub>RXREC</sub> | RXRECCLK maximum frequency  | Internal 20-bit data path | 187.5       | 187.5  | MHz   |
|                    |                             | Internal 16-bit data path | 234.38      | 234.38 | MHz   |
| T <sub>RX</sub>    | RXUSRCLK maximum frequency  |                           | 234.38      | 234.38 | MHz   |
| T <sub>RX2</sub>   | RXUSRCLK2 maximum frequency | 1 byte interface          | 376         | 312.5  | MHz   |
|                    |                             | 2 byte interface          | 234.38      | 234.38 | MHz   |
|                    |                             | 4 byte interface          | 117.19      | 117.19 | MHz   |
| T <sub>TX</sub>    | TXUSRCLK maximum frequency  |                           | 234.38      | 234.38 | MHz   |
| T <sub>TX2</sub>   | TXUSRCLK2 maximum frequency | 1 byte interface          | 376         | 312.5  | MHz   |
|                    |                             | 2 byte interface          | 234.38      | 234.38 | MHz   |
|                    |                             | 4 byte interface          | 117.19      | 117.19 | MHz   |

**Notes:**

1. Clocking must be implemented as described in *Virtex-6 FPGA GTX Transceivers User Guide*.

Table 31: GTX Transceiver Transmitter Switching Characteristics

| Symbol                       | Description                            | Condition                 | Min   | Typ | Max                 | Units |
|------------------------------|----------------------------------------|---------------------------|-------|-----|---------------------|-------|
| F <sub>GTXTX</sub>           | Serial data rate range                 |                           | 0.480 | —   | F <sub>GTXMAX</sub> | Gb/s  |
| T <sub>RTX</sub>             | TX Rise time                           | 20%–80%                   | —     | 120 | —                   | ps    |
| T <sub>FTX</sub>             | TX Fall time                           | 80%–20%                   | —     | 120 | —                   | ps    |
| T <sub>LLSKEW</sub>          | TX lane-to-lane skew <sup>(1)</sup>    |                           | —     | —   | 350                 | ps    |
| V <sub>TXOOBVDPP</sub>       | Electrical idle amplitude              |                           | —     | —   | 15                  | mV    |
| T <sub>TXOOBTRANSITION</sub> | Electrical idle transition time        |                           | —     | —   | 75                  | ns    |
| T <sub>J3.75</sub>           | Total Jitter <sup>(2)(3)</sup>         | 3.75 Gb/s                 | —     | —   | 0.34                | UI    |
| D <sub>J3.75</sub>           | Deterministic Jitter <sup>(2)(3)</sup> |                           | —     | —   | 0.16                | UI    |
| T <sub>J3.125</sub>          | Total Jitter <sup>(2)(3)</sup>         | 3.125 Gb/s                | —     | —   | 0.2                 | UI    |
| D <sub>J3.125</sub>          | Deterministic Jitter <sup>(2)(3)</sup> |                           | —     | —   | 0.1                 | UI    |
| T <sub>J3.125L</sub>         | Total Jitter <sup>(2)(3)</sup>         | 3.125 Gb/s <sup>(4)</sup> | —     | —   | 0.35                | UI    |
| D <sub>J3.125L</sub>         | Deterministic Jitter <sup>(2)(3)</sup> |                           | —     | —   | 0.16                | UI    |
| T <sub>J2.5</sub>            | Total Jitter <sup>(2)(3)</sup>         | 2.5 Gb/s <sup>(5)</sup>   | —     | —   | 0.20                | UI    |
| D <sub>J2.5</sub>            | Deterministic Jitter <sup>(2)(3)</sup> |                           | —     | —   | 0.08                | UI    |
| T <sub>J1.25</sub>           | Total Jitter <sup>(2)(3)</sup>         | 1.25 Gb/s <sup>(6)</sup>  | —     | —   | 0.15                | UI    |
| D <sub>J1.25</sub>           | Deterministic Jitter <sup>(2)(3)</sup> |                           | —     | —   | 0.06                | UI    |
| T <sub>J600</sub>            | Total Jitter <sup>(2)(3)</sup>         | 600 Mb/s                  | —     | —   | 0.1                 | UI    |
| D <sub>J600</sub>            | Deterministic Jitter <sup>(2)(3)</sup> |                           | —     | —   | 0.03                | UI    |

Table 31: GTX Transceiver Transmitter Switching Characteristics (Cont'd)

| Symbol            | Description                            | Condition | Min | Typ | Max  | Units |
|-------------------|----------------------------------------|-----------|-----|-----|------|-------|
| T <sub>J480</sub> | Total Jitter <sup>(2)(3)</sup>         | 480 Mb/s  | –   | –   | 0.1  | UI    |
| D <sub>J480</sub> | Deterministic Jitter <sup>(2)(3)</sup> |           | –   | –   | 0.03 | UI    |

**Notes:**

- Using same REFCLK input with TXENPMAPHASEALIGN enabled for up to four consecutive GTX transceiver sites.
- Using PLL\_DIVSEL\_FB = 2, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
- All jitter values are based on a bit-error ratio of 1e<sup>-12</sup>.
- PLL frequency at 1.5625 GHz and OUTDIV = 1.
- PLL frequency at 2.5 GHz and OUTDIV = 2.
- PLL frequency at 2.5 GHz and OUTDIV = 4.

Table 32: GTX Transceiver Receiver Switching Characteristics

| Symbol                                               | Description                                                   |                                          | Min   | Typ | Max                 | Units |
|------------------------------------------------------|---------------------------------------------------------------|------------------------------------------|-------|-----|---------------------|-------|
| F <sub>GTXRX</sub>                                   | Serial data rate                                              | RX oversampler not enabled               | 0.600 | –   | F <sub>GTXMAX</sub> | Gb/s  |
|                                                      |                                                               | RX oversampler enabled                   | 0.480 | –   | 0.600               | Gb/s  |
| T <sub>RXELECIDLE</sub>                              | Time for RXELECIdle to respond to loss or restoration of data |                                          | –     | 75  | –                   | ns    |
| R <sub>XOOBVDPP</sub>                                | OOB detect threshold peak-to-peak                             |                                          | 60    | –   | 150                 | mV    |
| R <sub>XSSST</sub>                                   | Receiver spread-spectrum tracking <sup>(1)</sup>              | Modulated @ 33 KHz                       | –5000 | –   | 0                   | ppm   |
| R <sub>XRL</sub>                                     | Run length (CID)                                              | Internal AC capacitor bypassed           | –     | –   | 512                 | UI    |
| R <sub>XPPMTOL</sub>                                 | Data/REFCLK PPM offset tolerance                              | CDR 2 <sup>nd</sup> -order loop disabled | –200  | –   | 200                 | ppm   |
|                                                      |                                                               | CDR 2 <sup>nd</sup> -order loop enabled  | –2000 | –   | 2000                | ppm   |
| SJ Jitter Tolerance <sup>(2)</sup>                   |                                                               |                                          |       |     |                     |       |
| JT_SJ <sub>3.75</sub>                                | Sinusoidal Jitter <sup>(3)</sup>                              | 3.75 Gb/s                                | 0.44  | –   | –                   | UI    |
| JT_SJ <sub>3.125</sub>                               | Sinusoidal Jitter <sup>(3)</sup>                              | 3.125 Gb/s                               | 0.45  | –   | –                   | UI    |
| JT_SJ <sub>3.125L</sub>                              | Sinusoidal Jitter <sup>(3)</sup>                              | 3.125 Gb/s <sup>(4)</sup>                | 0.45  | –   | –                   | UI    |
| JT_SJ <sub>2.5</sub>                                 | Sinusoidal Jitter <sup>(3)</sup>                              | 2.5 Gb/s <sup>(5)</sup>                  | 0.5   | –   | –                   | UI    |
| JT_SJ <sub>1.25</sub>                                | Sinusoidal Jitter <sup>(3)</sup>                              | 1.25 Gb/s <sup>(6)</sup>                 | 0.5   | –   | –                   | UI    |
| JT_SJ <sub>675</sub>                                 | Sinusoidal Jitter <sup>(3)</sup>                              | 675 Mb/s                                 | 0.4   | –   | –                   | UI    |
| JT_SJ <sub>480</sub>                                 | Sinusoidal Jitter <sup>(3)</sup>                              | 480 Mb/s                                 | 0.4   | –   | –                   | UI    |
| SJ Jitter Tolerance with Stressed Eye <sup>(2)</sup> |                                                               |                                          |       |     |                     |       |
| JT_TJSE <sub>3.125</sub>                             | Total Jitter with Stressed Eye <sup>(7)</sup>                 | 3.125 Gb/s                               | 0.70  | –   | –                   | UI    |
| JT_SJSE <sub>3.125</sub>                             | Sinusoidal Jitter with Stressed Eye <sup>(7)</sup>            | 3.125 Gb/s                               | 0.1   | –   | –                   | UI    |

**Notes:**

- Using PLL\_RXDIVSEL\_OUT = 1, 2, and 4.
- All jitter values are based on a bit-error ratio of 1e<sup>-12</sup>.
- The frequency of the injected sinusoidal jitter is 80 MHz.
- PLL frequency at 1.5625 GHz and OUTDIV = 1.
- PLL frequency at 2.5 GHz and OUTDIV = 2.
- PLL frequency at 2.5 GHz and OUTDIV = 4.
- Composite jitter with RX equalizer enabled. DFE disabled.

## Ethernet MAC Switching Characteristics

Consult *Virtex-6 FPGA Embedded Tri-mode Ethernet MAC User Guide* for further information.

Table 33: Maximum Ethernet MAC Performance

| Symbol                   | Description                          | Conditions               | Speed Grade        |                    | Units |
|--------------------------|--------------------------------------|--------------------------|--------------------|--------------------|-------|
|                          |                                      |                          | -2                 | -1                 |       |
| F <sub>TEMACCLIENT</sub> | Client interface maximum frequency   | 10 Mb/s – 8-bit width    | 2.5 <sup>(1)</sup> | 2.5 <sup>(1)</sup> | MHz   |
|                          |                                      | 100 Mb/s – 8-bit width   | 25 <sup>(2)</sup>  | 25 <sup>(2)</sup>  | MHz   |
|                          |                                      | 1000 Mb/s – 8-bit width  | 125                | 125                | MHz   |
|                          |                                      | 1000 Mb/s – 16-bit width | 62.5               | 62.5               | MHz   |
| F <sub>TEMACPHY</sub>    | Physical interface maximum frequency | 10 Mb/s – 4-bit width    | 2.5                | 2.5                | MHz   |
|                          |                                      | 100 Mb/s – 4-bit width   | 25                 | 25                 | MHz   |
|                          |                                      | 1000 Mb/s – 8-bit width  | 125                | 125                | MHz   |

### Notes:

1. When not using clock enable, the F<sub>MAX</sub> is lowered to 1.25 MHz.
2. When not using clock enable, the F<sub>MAX</sub> is lowered to 12.5 MHz.

## Integrated Interface Block for PCI Express Designs Switching Characteristics

More information and documentation on solutions for PCI Express designs can be found at:

<http://www.xilinx.com/technology/protocols/pciexpress.htm>

Table 34: Maximum Performance for PCI Express Designs

| Symbol               | Description                  | Speed Grade |     | Units |
|----------------------|------------------------------|-------------|-----|-------|
|                      |                              | -2          | -1  |       |
| F <sub>PIPECLK</sub> | Pipe clock maximum frequency | 125         | 125 | MHz   |
| F <sub>USERCLK</sub> | User clock maximum frequency | 250         | 250 | MHz   |
| F <sub>DRPCLK</sub>  | DRP clock maximum frequency  | 250         | 250 | MHz   |

## Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-6 CXT devices. The numbers reported here are worst-case values; they have all been fully characterized. These values are subject to the same guidelines as the [Switching Characteristics, page 25](#).

Table 35: Interface Performances

| Description                                                                         | Speed Grade |          |
|-------------------------------------------------------------------------------------|-------------|----------|
|                                                                                     | -2          | -1       |
| <b>Networking Applications</b>                                                      |             |          |
| SDR LVDS transmitter (using OSERDES; DATA_WIDTH = 4 to 8)                           | 650 Mb/s    | 625 Mb/s |
| DDR LVDS transmitter (using OSERDES; DATA_WIDTH = 4 to 10)                          | 1.25 Gb/s   | 1.0 Gb/s |
| SDR LVDS receiver (SFI-4.1) <sup>(1)</sup>                                          | 650 Mb/s    | 625 Mb/s |
| DDR LVDS receiver (SFI-4.2) <sup>(1)</sup>                                          | 1.0 Gb/s    | 0.9 Gb/s |
| <b>Maximum Physical Interface (PHY) Rate for Memory Interfaces<sup>(2)(3)</sup></b> |             |          |
| DDR2                                                                                | 666 Mb/s    | 666 Mb/s |
| DDR3                                                                                | 800 Mb/s    | 666 Mb/s |
| QDR II + SRAM                                                                       | 250 MHz     | 250 MHz  |

### Notes:

1. LVDS receivers are typically bounded with certain applications where specific DPA algorithms dominate deterministic performance.
2. Based on Xilinx memory characterization platforms designed according to the guidelines in the *Virtex-6 FPGA Memory Interface Solutions User Guide*.
3. Consult the *Virtex-6 FPGA Memory Interface Solutions Data Sheet* for performance and feature information on memory interface cores (controller plus PHY).



## Switching Characteristics

All values represented in this data sheet are based on the speed specification (version 1.08). Switching characteristics are specified on a per-speed-grade basis and can be designated as Advance, Preliminary, or Production. Each designation is defined as follows:

### Advance

These specifications are based on simulations only and are typically available soon after device design specifications are frozen. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

### Preliminary

These specifications are based on complete ES (engineering sample) silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting delays is greatly reduced as compared to Advance data.

## Testing of Switching Characteristics

All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values.

## Production Silicon and ISE Software Status

In some cases, a particular family member (and speed grade) is released to production before a speed specification is released with the correct label (Advance, Preliminary, Production). Any labeling discrepancies are corrected in subsequent speed specification releases. [Table 37](#) lists the production released Virtex-6 family member, speed grade, and the minimum corresponding supported speed specification version and ISE software revisions. The ISE® software and speed specifications listed are the minimum releases required for production. All subsequent releases of software and speed specifications are valid.

## Production

These specifications are released once enough production silicon of a particular device family member has been characterized to provide full correlation between specifications and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

All specifications are always representative of worst-case supply voltage and junction temperature conditions.

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device.

[Table 36](#) correlates the current status of each Virtex-6 CXT device on a per speed grade basis.

**Table 36: Virtex-6 CXT Device/Speed Grade Designations**

| Device     | Speed Grade Designations |             |            |
|------------|--------------------------|-------------|------------|
|            | Advance                  | Preliminary | Production |
| XC6VCX75T  |                          |             | -2, -1     |
| XC6VCX130T |                          |             | -2, -1     |
| XC6VCX195T |                          |             | -2, -1     |
| XC6VCX240T |                          |             | -2, -1     |

For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer and back-annotate to the simulation net list. Unless otherwise noted, values apply to all Virtex-6 CXT devices.

**Table 37: Virtex-6 CXT Device/Production Software and Speed Specification Release**

| Device     | Speed Grade Designations               |    |
|------------|----------------------------------------|----|
|            | -2                                     | -1 |
| XC6VCX75T  | ISE 12.2 (with speed file patch) v1.06 |    |
| XC6VCX130T | ISE 12.1 v1.04                         |    |
| XC6VCX195T | ISE 12.2 (with speed file patch) v1.06 |    |
| XC6VCX240T | ISE 12.1 v1.04                         |    |

### Notes:

- Blank entries indicate a device and/or speed grade in advance or preliminary status.

## IOB Pad Input/Output/3-State Switching Characteristics

Table 38 summarizes the values of standard-specific data input delay adjustments, output delays terminating at pads (based on standard) and 3-state delays.

$T_{IOPI}$  is described as the delay from IOB pad through the input buffer to the I-pin of an IOB pad. The delay varies depending on the capability of the SelectIO input buffer.

$T_{IOOP}$  is described as the delay from the O pin to the IOB pad through the output buffer of an IOB pad. The delay varies depending on the capability of the SelectIO output buffer.

$T_{IOTP}$  is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is disabled. The delay varies depending on the SelectIO capability of the output buffer.

Table 39 summarizes the value of  $T_{IOTPHZ}$ .  $T_{IOTPHZ}$  is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is enabled (i.e., a high impedance state).

Table 38: IOB Switching Characteristics

| I/O Standard             | T <sub>IOPI</sub> |      | T <sub>IOOP</sub> |      | T <sub>IOTP</sub> |      | Units |
|--------------------------|-------------------|------|-------------------|------|-------------------|------|-------|
|                          | Speed Grade       |      | Speed Grade       |      | Speed Grade       |      |       |
|                          | -2                | -1   | -2                | -1   | -2                | -1   |       |
| LVDS_25                  | 1.09              | 1.09 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| LVDSEXT_25               | 1.09              | 1.09 | 1.84              | 1.84 | 1.84              | 1.84 | ns    |
| HT_25                    | 1.09              | 1.09 | 1.78              | 1.78 | 1.78              | 1.78 | ns    |
| BLVDS_25                 | 1.09              | 1.09 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| RSDS_25 (point to point) | 1.09              | 1.09 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| HSTL_I                   | 1.06              | 1.06 | 1.73              | 1.73 | 1.73              | 1.73 | ns    |
| HSTL_II                  | 1.06              | 1.06 | 1.74              | 1.74 | 1.74              | 1.74 | ns    |
| HSTL_III                 | 1.06              | 1.06 | 1.71              | 1.71 | 1.71              | 1.71 | ns    |
| HSTL_I_18                | 1.06              | 1.06 | 1.75              | 1.75 | 1.75              | 1.75 | ns    |
| HSTL_II_18               | 1.06              | 1.06 | 1.81              | 1.81 | 1.81              | 1.81 | ns    |
| HSTL_III_18              | 1.06              | 1.06 | 1.71              | 1.71 | 1.71              | 1.71 | ns    |
| SSTL2_I                  | 1.06              | 1.06 | 1.77              | 1.77 | 1.77              | 1.77 | ns    |
| SSTL2_II                 | 1.06              | 1.06 | 1.72              | 1.72 | 1.72              | 1.72 | ns    |
| SSTL15                   | 1.06              | 1.06 | 1.71              | 1.71 | 1.71              | 1.71 | ns    |
| LVC MOS25, Slow, 2 mA    | 0.66              | 0.66 | 6.01              | 6.01 | 6.01              | 6.01 | ns    |
| LVC MOS25, Slow, 4 mA    | 0.66              | 0.66 | 3.79              | 3.79 | 3.79              | 3.79 | ns    |
| LVC MOS25, Slow, 6 mA    | 0.66              | 0.66 | 3.08              | 3.08 | 3.08              | 3.08 | ns    |
| LVC MOS25, Slow, 8 mA    | 0.66              | 0.66 | 2.72              | 2.72 | 2.72              | 2.72 | ns    |
| LVC MOS25, Slow, 12 mA   | 0.66              | 0.66 | 2.17              | 2.17 | 2.17              | 2.17 | ns    |
| LVC MOS25, Slow, 16 mA   | 0.66              | 0.66 | 2.29              | 2.29 | 2.29              | 2.29 | ns    |
| LVC MOS25, Slow, 24 mA   | 0.66              | 0.66 | 2.02              | 2.02 | 2.02              | 2.02 | ns    |
| LVC MOS25, Fast, 2 mA    | 0.66              | 0.66 | 6.04              | 6.04 | 6.04              | 6.04 | ns    |
| LVC MOS25, Fast, 4 mA    | 0.66              | 0.66 | 3.82              | 3.82 | 3.82              | 3.82 | ns    |
| LVC MOS25, Fast, 6 mA    | 0.66              | 0.66 | 2.99              | 2.99 | 2.99              | 2.99 | ns    |
| LVC MOS25, Fast, 8 mA    | 0.66              | 0.66 | 2.65              | 2.65 | 2.65              | 2.65 | ns    |
| LVC MOS25, Fast, 12 mA   | 0.66              | 0.66 | 2.08              | 2.08 | 2.08              | 2.08 | ns    |
| LVC MOS25, Fast, 16 mA   | 0.66              | 0.66 | 2.13              | 2.13 | 2.13              | 2.13 | ns    |
| LVC MOS25, Fast, 24 mA   | 0.66              | 0.66 | 1.99              | 1.99 | 1.99              | 1.99 | ns    |

Table 38: IOB Switching Characteristics (Cont'd)

| I/O Standard           | T <sub>IOPI</sub> |      | T <sub>IOOP</sub> |      | T <sub>IOTP</sub> |      | Units |
|------------------------|-------------------|------|-------------------|------|-------------------|------|-------|
|                        | Speed Grade       |      | Speed Grade       |      | Speed Grade       |      |       |
|                        | -2                | -1   | -2                | -1   | -2                | -1   |       |
| LVC MOS18, Slow, 2 mA  | 0.71              | 0.71 | 4.87              | 4.87 | 4.87              | 4.87 | ns    |
| LVC MOS18, Slow, 4 mA  | 0.71              | 0.71 | 3.21              | 3.21 | 3.21              | 3.21 | ns    |
| LVC MOS18, Slow, 6 mA  | 0.71              | 0.71 | 2.64              | 2.64 | 2.64              | 2.64 | ns    |
| LVC MOS18, Slow, 8 mA  | 0.71              | 0.71 | 2.27              | 2.27 | 2.27              | 2.27 | ns    |
| LVC MOS18, Slow, 12 mA | 0.71              | 0.71 | 2.15              | 2.15 | 2.15              | 2.15 | ns    |
| LVC MOS18, Slow, 16 mA | 0.71              | 0.71 | 2.11              | 2.11 | 2.11              | 2.11 | ns    |
| LVC MOS18, Fast, 2 mA  | 0.71              | 0.71 | 4.57              | 4.57 | 4.57              | 4.57 | ns    |
| LVC MOS18, Fast, 4 mA  | 0.71              | 0.71 | 2.97              | 2.97 | 2.97              | 2.97 | ns    |
| LVC MOS18, Fast, 6 mA  | 0.71              | 0.71 | 2.46              | 2.46 | 2.46              | 2.46 | ns    |
| LVC MOS18, Fast, 8 mA  | 0.71              | 0.71 | 2.13              | 2.13 | 2.13              | 2.13 | ns    |
| LVC MOS18, Fast, 12 mA | 0.71              | 0.71 | 1.97              | 1.97 | 1.97              | 1.97 | ns    |
| LVC MOS18, Fast, 16 mA | 0.71              | 0.71 | 1.91              | 1.91 | 1.91              | 1.91 | ns    |
| LVC MOS15, Slow, 2 mA  | 0.85              | 0.85 | 4.29              | 4.29 | 4.29              | 4.29 | ns    |
| LVC MOS15, Slow, 4 mA  | 0.85              | 0.85 | 3.10              | 3.10 | 3.10              | 3.10 | ns    |
| LVC MOS15, Slow, 6 mA  | 0.85              | 0.85 | 2.68              | 2.68 | 2.68              | 2.68 | ns    |
| LVC MOS15, Slow, 8 mA  | 0.85              | 0.85 | 2.23              | 2.23 | 2.23              | 2.23 | ns    |
| LVC MOS15, Slow, 12 mA | 0.85              | 0.85 | 2.13              | 2.13 | 2.13              | 2.13 | ns    |
| LVC MOS15, Slow, 16 mA | 0.85              | 0.85 | 2.04              | 2.04 | 2.04              | 2.04 | ns    |
| LVC MOS15, Fast, 2 mA  | 0.85              | 0.85 | 4.28              | 4.28 | 4.28              | 4.28 | ns    |
| LVC MOS15, Fast, 4 mA  | 0.85              | 0.85 | 2.78              | 2.78 | 2.78              | 2.78 | ns    |
| LVC MOS15, Fast, 6 mA  | 0.85              | 0.85 | 2.42              | 2.42 | 2.42              | 2.42 | ns    |
| LVC MOS15, Fast, 8 mA  | 0.85              | 0.85 | 2.11              | 2.11 | 2.11              | 2.11 | ns    |
| LVC MOS15, Fast, 12 mA | 0.85              | 0.85 | 1.97              | 1.97 | 1.97              | 1.97 | ns    |
| LVC MOS15, Fast, 16 mA | 0.85              | 0.85 | 1.96              | 1.96 | 1.96              | 1.96 | ns    |
| LVC MOS12, Slow, 2 mA  | 0.93              | 0.93 | 3.75              | 3.75 | 3.75              | 3.75 | ns    |
| LVC MOS12, Slow, 4 mA  | 0.93              | 0.93 | 2.93              | 2.93 | 2.93              | 2.93 | ns    |
| LVC MOS12, Slow, 6 mA  | 0.93              | 0.93 | 2.41              | 2.41 | 2.41              | 2.41 | ns    |
| LVC MOS12, Slow, 8 mA  | 0.93              | 0.93 | 2.25              | 2.25 | 2.25              | 2.25 | ns    |
| LVC MOS12, Fast, 2 mA  | 0.93              | 0.93 | 3.39              | 3.39 | 3.39              | 3.39 | ns    |
| LVC MOS12, Fast, 4 mA  | 0.93              | 0.93 | 2.51              | 2.51 | 2.51              | 2.51 | ns    |
| LVC MOS12, Fast, 6 mA  | 0.93              | 0.93 | 2.11              | 2.11 | 2.11              | 2.11 | ns    |
| LVC MOS12, Fast, 8 mA  | 0.93              | 0.93 | 2.02              | 2.02 | 2.02              | 2.02 | ns    |
| LVDCI_25               | 0.66              | 0.66 | 2.26              | 2.26 | 2.26              | 2.26 | ns    |
| LVDCI_18               | 0.71              | 0.71 | 2.47              | 2.47 | 2.47              | 2.47 | ns    |
| LVDCI_15               | 0.85              | 0.85 | 2.24              | 2.24 | 2.24              | 2.24 | ns    |
| LVDCI_DV2_25           | 0.66              | 0.66 | 2.01              | 2.01 | 2.01              | 2.01 | ns    |
| LVDCI_DV2_18           | 0.71              | 0.71 | 2.00              | 2.00 | 2.00              | 2.00 | ns    |
| LVDCI_DV2_15           | 0.85              | 0.85 | 1.91              | 1.91 | 1.91              | 1.91 | ns    |

Table 38: IOB Switching Characteristics (Cont'd)

| I/O Standard          | T <sub>IOPI</sub> |      | T <sub>IOOP</sub> |      | T <sub>IOTP</sub> |      | Units |
|-----------------------|-------------------|------|-------------------|------|-------------------|------|-------|
|                       | Speed Grade       |      | Speed Grade       |      | Speed Grade       |      |       |
|                       | -2                | -1   | -2                | -1   | -2                | -1   |       |
| LVPECL_25             | 1.09              | 1.09 | 1.65              | 1.65 | 1.65              | 1.65 | ns    |
| HSTL_I_12             | 1.06              | 1.06 | 1.78              | 1.78 | 1.78              | 1.78 | ns    |
| HSTL_I_DCI            | 1.06              | 1.06 | 1.66              | 1.66 | 1.66              | 1.66 | ns    |
| HSTL_II_DCI           | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| HSTL_II_T_DCI         | 1.06              | 1.06 | 1.66              | 1.66 | 1.66              | 1.66 | ns    |
| HSTL_III_DCI          | 1.06              | 1.06 | 1.62              | 1.62 | 1.62              | 1.62 | ns    |
| HSTL_I_DCI_18         | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| HSTL_II_DCI_18        | 1.06              | 1.06 | 1.62              | 1.62 | 1.62              | 1.62 | ns    |
| HSTL_II_T_DCI_18      | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| HSTL_III_DCI_18       | 1.06              | 1.06 | 1.69              | 1.69 | 1.69              | 1.69 | ns    |
| DIFF_HSTL_I_18        | 1.09              | 1.09 | 1.75              | 1.75 | 1.75              | 1.75 | ns    |
| DIFF_HSTL_I_DCI_18    | 1.09              | 1.09 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| DIFF_HSTL_I           | 1.09              | 1.09 | 1.73              | 1.73 | 1.73              | 1.73 | ns    |
| DIFF_HSTL_I_DCI       | 1.09              | 1.09 | 1.66              | 1.66 | 1.66              | 1.66 | ns    |
| DIFF_HSTL_II_18       | 1.09              | 1.09 | 1.81              | 1.81 | 1.81              | 1.81 | ns    |
| DIFF_HSTL_II_DCI_18   | 1.09              | 1.09 | 1.62              | 1.62 | 1.62              | 1.62 | ns    |
| DIFF_HSTL_II_T_DCI_18 | 1.09              | 1.09 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| DIFF_HSTL_II          | 1.09              | 1.09 | 1.74              | 1.74 | 1.74              | 1.74 | ns    |
| DIFF_HSTL_II_DCI      | 1.09              | 1.09 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| SSTL2_I_DCI           | 1.06              | 1.06 | 1.70              | 1.70 | 1.70              | 1.70 | ns    |
| SSTL2_II_DCI          | 1.06              | 1.06 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| SSTL2_II_T_DCI        | 1.06              | 1.06 | 1.70              | 1.70 | 1.70              | 1.70 | ns    |
| SSTL18_I              | 1.06              | 1.06 | 1.75              | 1.75 | 1.75              | 1.75 | ns    |
| SSTL18_II             | 1.06              | 1.06 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| SSTL18_I_DCI          | 1.06              | 1.06 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| SSTL18_II_DCI         | 1.06              | 1.06 | 1.63              | 1.63 | 1.63              | 1.63 | ns    |
| SSTL18_II_T_DCI       | 1.06              | 1.06 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| SSTL15_T_DCI          | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| SSTL15_DCI            | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| DIFF_SSTL2_I          | 1.09              | 1.09 | 1.77              | 1.77 | 1.77              | 1.77 | ns    |
| DIFF_SSTL2_I_DCI      | 1.09              | 1.09 | 1.70              | 1.70 | 1.70              | 1.70 | ns    |
| DIFF_SSTL2_II         | 1.09              | 1.09 | 1.72              | 1.72 | 1.72              | 1.72 | ns    |
| DIFF_SSTL2_II_DCI     | 1.09              | 1.09 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| DIFF_SSTL2_II_T_DCI   | 1.09              | 1.09 | 1.70              | 1.70 | 1.70              | 1.70 | ns    |
| DIFF_SSTL18_I         | 1.09              | 1.09 | 1.75              | 1.75 | 1.75              | 1.75 | ns    |
| DIFF_SSTL18_I_DCI     | 1.09              | 1.09 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| DIFF_SSTL18_II        | 1.09              | 1.09 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| DIFF_SSTL18_II_DCI    | 1.09              | 1.09 | 1.63              | 1.63 | 1.63              | 1.63 | ns    |

Table 38: IOB Switching Characteristics (Cont'd)

| I/O Standard         | T <sub>IOPI</sub> |      | T <sub>IOOP</sub> |      | T <sub>IOTP</sub> |      | Units |
|----------------------|-------------------|------|-------------------|------|-------------------|------|-------|
|                      | Speed Grade       |      | Speed Grade       |      | Speed Grade       |      |       |
|                      | -2                | -1   | -2                | -1   | -2                | -1   |       |
| DIFF_SSTL18_II_T_DCI | 1.09              | 1.09 | 1.67              | 1.67 | 1.67              | 1.67 | ns    |
| DIFF_SSTL15          | 1.06              | 1.06 | 1.71              | 1.71 | 1.71              | 1.71 | ns    |
| DIFF_SSTL15_DCI      | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |
| DIFF_SSTL15_T_DCI    | 1.06              | 1.06 | 1.68              | 1.68 | 1.68              | 1.68 | ns    |

Table 39: IOB 3-state ON Output Switching Characteristics (T<sub>IOTPHZ</sub>)

| Symbol              | Description                   | Speed Grade |      | Units |
|---------------------|-------------------------------|-------------|------|-------|
|                     |                               | -2          | -1   |       |
| T <sub>IOTPHZ</sub> | T input to Pad high-impedance | 0.99        | 0.99 | ns    |

## I/O Standard Adjustment Measurement Methodology

### Input Delay Measurements

Table 40 shows the test setup parameters used for measuring input delay.

Table 40: Input Delay Measurement Methodology

| Description                                                  | I/O Standard Attribute | V <sub>L</sub> (1)(2)   | V <sub>H</sub> (1)(2)   | V <sub>MEAS</sub> (1,4,5) | V <sub>REF</sub> (1,3,5) |
|--------------------------------------------------------------|------------------------|-------------------------|-------------------------|---------------------------|--------------------------|
| LVC MOS, 2.5V                                                | LVC MOS25              | 0                       | 2.5                     | 1.25                      | —                        |
| LVC MOS, 1.8V                                                | LVC MOS18              | 0                       | 1.8                     | 0.9                       | —                        |
| LVC MOS, 1.5V                                                | LVC MOS15              | 0                       | 1.5                     | 0.75                      | —                        |
| HSTL (High-Speed Transceiver Logic), Class I & II            | HSTL_I, HSTL_II        | V <sub>REF</sub> – 0.5  | V <sub>REF</sub> + 0.5  | V <sub>REF</sub>          | 0.75                     |
| HSTL, Class III                                              | HSTL_III               | V <sub>REF</sub> – 0.5  | V <sub>REF</sub> + 0.5  | V <sub>REF</sub>          | 0.90                     |
| HSTL, Class I & II, 1.8V                                     | HSTL_I_18, HSTL_II_18  | V <sub>REF</sub> – 0.5  | V <sub>REF</sub> + 0.5  | V <sub>REF</sub>          | 0.90                     |
| HSTL, Class III 1.8V                                         | HSTL_III_18            | V <sub>REF</sub> – 0.5  | V <sub>REF</sub> + 0.5  | V <sub>REF</sub>          | 1.08                     |
| SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V | SSTL3_I, SSTL3_II      | V <sub>REF</sub> – 1.00 | V <sub>REF</sub> + 1.00 | V <sub>REF</sub>          | 1.5                      |
| SSTL, Class I & II, 2.5V                                     | SSTL2_I, SSTL2_II      | V <sub>REF</sub> – 0.75 | V <sub>REF</sub> + 0.75 | V <sub>REF</sub>          | 1.25                     |
| SSTL, Class I & II, 1.8V                                     | SSTL18_I, SSTL18_II    | V <sub>REF</sub> – 0.5  | V <sub>REF</sub> + 0.5  | V <sub>REF</sub>          | 0.90                     |
| LVDS (Low-Voltage Differential Signaling), 2.5V              | LVDS_25                | 1.2 – 0.125             | 1.2 + 0.125             | 0 <sup>(6)</sup>          | —                        |
| LVDS EXT (LVDS Extended Mode), 2.5V                          | LVDS EXT_25            | 1.2 – 0.125             | 1.2 + 0.125             | 0 <sup>(6)</sup>          | —                        |
| HT (HyperTransport), 2.5V                                    | LDT_25                 | 0.6 – 0.125             | 0.6 + 0.125             | 0 <sup>(6)</sup>          | —                        |

#### Notes:

1. The input delay measurement methodology parameters for LVDCI are the same for LVC MOS standards of the same voltage. Input delay measurement methodology parameters for HSLVDCI are the same as for HSTL\_II standards of the same voltage. Parameters for all other DCI standards are the same for the corresponding non-DCI standards.
2. Input waveform switches between V<sub>L</sub> and V<sub>H</sub>.
3. Measurements are made at typical, minimum, and maximum V<sub>REF</sub> values. Reported delays reflect worst case of these measurements. V<sub>REF</sub> values listed are typical.
4. Input voltage level from which measurement starts.
5. This is an input voltage reference that bears no relation to the V<sub>REF</sub> / V<sub>MEAS</sub> parameters found in IBIS models and/or noted in Figure 14.
6. The value given is the differential output voltage.

## Output Delay Measurements

Output delays are measured using a Tektronix P6245 TDS500/600 probe (< 1 pF) across approximately 4" of FR4 microstrip trace. Standard termination was used for all testing. The propagation delay of the 4" trace is characterized separately and subtracted from the final measurement, and is therefore not included in the generalized test setups shown in Figure 14 and Figure 15.

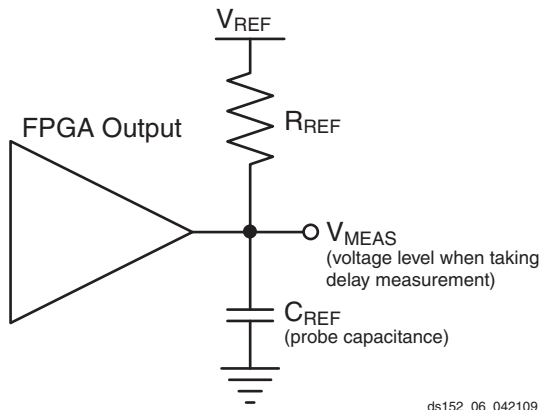
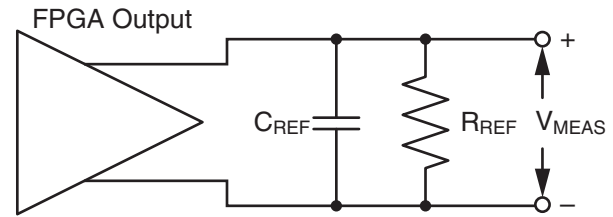


Figure 14: Single Ended Test Setup



ds152\_07\_042109

Figure 15: Differential Test Setup

Measurements and test conditions are reflected in the IBIS models except where the IBIS format precludes it. Parameters  $V_{REF}$ ,  $R_{REF}$ ,  $C_{REF}$ , and  $V_{MEAS}$  fully describe the test conditions for each I/O standard. The most accurate prediction of propagation delay in any given application can be obtained through IBIS simulation, using the following method:

1. Simulate the output driver of choice into the generalized test setup, using values from Table 41.
2. Record the time to  $V_{MEAS}$ .
3. Simulate the output driver of choice into the actual PCB trace and load, using the appropriate IBIS model or capacitance value to represent the load.
4. Record the time to  $V_{MEAS}$ .
5. Compare the results of steps 2 and 4. The increase or decrease in delay yields the actual propagation delay of the PCB trace.

Table 41: Output Delay Measurement Methodology

| Description                                        | I/O Standard Attribute | $R_{REF}$ ( $\Omega$ ) | $C_{REF}^{(1)}$ (pF) | $V_{MEAS}$ (V)   | $V_{REF}$ (V) |
|----------------------------------------------------|------------------------|------------------------|----------------------|------------------|---------------|
| LVC MOS, 2.5V                                      | LVC MOS25              | 1M                     | 0                    | 1.25             | 0             |
| LVC MOS, 1.8V                                      | LVC MOS18              | 1M                     | 0                    | 0.9              | 0             |
| LVC MOS, 1.5V                                      | LVC MOS15              | 1M                     | 0                    | 0.75             | 0             |
| LVC MOS, 1.2V                                      | LVC MOS12              | 1M                     | 0                    | 0.75             | 0             |
| HSTL (High-Speed Transceiver Logic), Class I       | HSTL_I                 | 50                     | 0                    | $V_{REF}$        | 0.75          |
| HSTL, Class II                                     | HSTL_II                | 25                     | 0                    | $V_{REF}$        | 0.75          |
| HSTL, Class III                                    | HSTL_III               | 50                     | 0                    | 0.9              | 1.5           |
| HSTL, Class I, 1.8V                                | HSTL_I_18              | 50                     | 0                    | $V_{REF}$        | 0.9           |
| HSTL, Class II, 1.8V                               | HSTL_II_18             | 25                     | 0                    | $V_{REF}$        | 0.9           |
| HSTL, Class III, 1.8V                              | HSTL_III_18            | 50                     | 0                    | 1.1              | 1.8           |
| SSTL (Stub Series Terminated Logic), Class I, 1.8V | SSTL18_I               | 50                     | 0                    | $V_{REF}$        | 0.9           |
| SSTL, Class II, 1.8V                               | SSTL18_II              | 25                     | 0                    | $V_{REF}$        | 0.9           |
| SSTL, Class I, 2.5V                                | SSTL2_I                | 50                     | 0                    | $V_{REF}$        | 1.25          |
| SSTL, Class II, 2.5V                               | SSTL2_II               | 25                     | 0                    | $V_{REF}$        | 1.25          |
| LVDS (Low-Voltage Differential Signaling), 2.5V    | LVDS_25                | 100                    | 0                    | 0 <sup>(2)</sup> | 1.2           |
| LVDS EXT (LVDS Extended Mode), 2.5V                | LVDS_25                | 100                    | 0                    | 0 <sup>(2)</sup> | 1.2           |
| BLVDS (Bus LVDS), 2.5V                             | BLVDS_25               | 100                    | 0                    | 0 <sup>(2)</sup> | 0             |

Table 41: Output Delay Measurement Methodology (Cont'd)

| Description                                                    | I/O Standard Attribute        | R <sub>REF</sub><br>(Ω) | C <sub>REF</sub> <sup>(1)</sup><br>(pF) | V <sub>MEAS</sub><br>(V) | V <sub>REF</sub><br>(V) |
|----------------------------------------------------------------|-------------------------------|-------------------------|-----------------------------------------|--------------------------|-------------------------|
| HT (HyperTransport), 2.5V                                      | LDT_25                        | 100                     | 0                                       | 0 <sup>(2)</sup>         | 0.6                     |
| LVPECL (Low-Voltage Positive Emitter-Coupled Logic), 2.5V      | LVPECL_25                     | 100                     | 0                                       | 0 <sup>(2)</sup>         | 0                       |
| LVDCI/HSLVDCI, 2.5V                                            | LVDCI_25, HSLVDCI_25          | 1M                      | 0                                       | 1.25                     | 0                       |
| LVDCI/HSLVDCI, 1.8V                                            | LVDCI_18, HSLVDCI_18          | 1M                      | 0                                       | 0.9                      | 0                       |
| LVDCI/HSLVDCI, 1.5V                                            | LVDCI_15, HSLVDCI_15          | 1M                      | 0                                       | 0.75                     | 0                       |
| HSTL (High-Speed Transceiver Logic), Class I & II, with DCI    | HSTL_I_DCI, HSTL_II_DCI       | 50                      | 0                                       | V <sub>REF</sub>         | 0.75                    |
| HSTL, Class III, with DCI                                      | HSTL_III_DCI                  | 50                      | 0                                       | 0.9                      | 1.5                     |
| HSTL, Class I & II, 1.8V, with DCI                             | HSTL_I_DCI_18, HSTL_II_DCI_18 | 50                      | 0                                       | V <sub>REF</sub>         | 0.9                     |
| HSTL, Class III, 1.8V, with DCI                                | HSTL_III_DCI_18               | 50                      | 0                                       | 1.1                      | 1.8                     |
| SSTL (Stub Series Termini.Logic), Class I & II, 1.8V, with DCI | SSTL18_I_DCI, SSTL18_II_DCI   | 50                      | 0                                       | V <sub>REF</sub>         | 0.9                     |
| SSTL, Class I & II, 2.5V, with DCI                             | SSTL2_I_DCI, SSTL2_II_DCI     | 50                      | 0                                       | V <sub>REF</sub>         | 1.25                    |

**Notes:**

1. C<sub>REF</sub> is the capacitance of the probe, nominally 0 pF.
2. The value given is the differential output voltage.

**Input/Output Logic Switching Characteristics**

Table 42: ILOGIC Switching Characteristics

| Symbol                                   | Description                                                   | Speed Grade |            | Units   |
|------------------------------------------|---------------------------------------------------------------|-------------|------------|---------|
|                                          |                                                               | -2          | -1         |         |
| Setup/Hold                               |                                                               |             |            |         |
| T <sub>ICE1CK</sub> /T <sub>ICKCE1</sub> | CE1 pin Setup/Hold with respect to CLK                        | 0.27/0.04   | 0.27/0.04  | ns      |
| T <sub>ISRCK</sub> /T <sub>ICKSR</sub>   | SR pin Setup/Hold with respect to CLK                         | 0.96/–0.10  | 0.96/–0.10 | ns      |
| T <sub>IDOCK</sub> /T <sub>IOCKD</sub>   | D pin Setup/Hold with respect to CLK without Delay            | 0.10/0.54   | 0.10/0.54  | ns      |
| T <sub>IDOCKD</sub> /T <sub>IOCKDD</sub> | DDLY pin Setup/Hold with respect to CLK (using IODELAY)       | 0.14/0.42   | 0.14/0.40  | ns      |
| Combinatorial                            |                                                               |             |            |         |
| T <sub>IDI</sub>                         | D pin to O pin propagation delay, no Delay                    | 0.20        | 0.20       | ns      |
| T <sub>IDID</sub>                        | DDLY pin to O pin propagation delay (using IODELAY)           | 0.25        | 0.25       | ns      |
| Sequential Delays                        |                                                               |             |            |         |
| T <sub>IDLO</sub>                        | D pin to Q1 pin using flip-flop as a latch without Delay      | 0.64        | 0.64       | ns      |
| T <sub>IDLOD</sub>                       | DDLY pin to Q1 pin using flip-flop as a latch (using IODELAY) | 0.68        | 0.68       | ns      |
| T <sub>ICKQ</sub>                        | CLK to Q outputs                                              | 0.71        | 0.71       | ns      |
| T <sub>RQ_ILOGIC</sub>                   | SR pin to OQ/TQ out                                           | 1.15        | 1.15       | ns      |
| T <sub>GSRQ_ILOGIC</sub>                 | Global Set/Reset to Q outputs                                 | 10.51       | 10.51      | ns      |
| Set/Reset                                |                                                               |             |            |         |
| T <sub>RPW_ILOGIC</sub>                  | Minimum Pulse Width, SR inputs                                | 1.20        | 1.20       | ns, Min |

Table 43: OLOGIC Switching Characteristics

| Symbol                                   | Description                               | Speed Grade |            | Units   |
|------------------------------------------|-------------------------------------------|-------------|------------|---------|
|                                          |                                           | -2          | -1         |         |
| Setup/Hold                               |                                           |             |            |         |
| T <sub>ODCK</sub> /T <sub>OCKD</sub>     | D1/D2 pins Setup/Hold with respect to CLK | 0.54/−0.11  | 0.54/−0.11 | ns      |
| T <sub>OOCECK</sub> /T <sub>OCKOCE</sub> | OCE pin Setup/Hold with respect to CLK    | 0.22/−0.05  | 0.22/−0.05 | ns      |
| T <sub>OSRCK</sub> /T <sub>OCKSR</sub>   | SR pin Setup/Hold with respect to CLK     | 0.71/−0.29  | 0.71/−0.29 | ns      |
| T <sub>OTCK</sub> /T <sub>OCKT</sub>     | T1/T2 pins Setup/Hold with respect to CLK | 0.56/−0.10  | 0.56/−0.10 | ns      |
| T <sub>OTCECK</sub> /T <sub>OCKTCE</sub> | TCE pin Setup/Hold with respect to CLK    | 0.21/−0.05  | 0.21/−0.05 | ns      |
| Combinatorial                            |                                           |             |            |         |
| T <sub>DOQ</sub>                         | D1 to OQ out or T1 to TQ out              | 1.01        | 1.01       | ns      |
| Sequential Delays                        |                                           |             |            |         |
| T <sub>OCKQ</sub>                        | CLK to OQ/TQ out                          | 0.71        | 0.71       | ns      |
| T <sub>RQ</sub>                          | SR pin to OQ/TQ out                       | 1.05        | 1.05       | ns      |
| T <sub>GSRQ</sub>                        | Global Set/Reset to Q outputs             | 10.51       | 10.51      | ns      |
| Set/Reset                                |                                           |             |            |         |
| T <sub>RPW</sub>                         | Minimum Pulse Width, SR inputs            | 1.20        | 1.20       | ns, Min |

## Input Serializer/Deserializer Switching Characteristics

Table 44: ISERDES Switching Characteristics

| Symbol                                                         | Description                                                                     | Speed Grade |            | Units |
|----------------------------------------------------------------|---------------------------------------------------------------------------------|-------------|------------|-------|
|                                                                |                                                                                 | -2          | -1         |       |
| Setup/Hold for Control Lines                                   |                                                                                 |             |            |       |
| T <sub>ISCKK_BITS</sub> SLIP/ T <sub>ISCKC_BITS</sub> SLIP     | BITS <sub>SLIP</sub> pin Setup/Hold with respect to CLKDIV                      | 0.09/0.17   | 0.09/0.17  | ns    |
| T <sub>ISCKK_CE</sub> / T <sub>ISCKC_CE</sub> <sup>(2)</sup>   | CE pin Setup/Hold with respect to CLK (for CE1)                                 | 0.27/0.04   | 0.27/0.04  | ns    |
| T <sub>ISCKK_CE2</sub> / T <sub>ISCKC_CE2</sub> <sup>(2)</sup> | CE pin Setup/Hold with respect to CLKDIV (for CE2)                              | –0.06/0.31  | –0.06/0.31 | ns    |
| Setup/Hold for Data Lines                                      |                                                                                 |             |            |       |
| T <sub>ISDCK_D</sub> /T <sub>ISCKD_D</sub>                     | D pin Setup/Hold with respect to CLK                                            | 0.09/0.11   | 0.09/0.11  | ns    |
| T <sub>ISDCK_DDLY</sub> /T <sub>ISCKD_DDLY</sub>               | DDLY pin Setup/Hold with respect to CLK (using IODELAY) <sup>(1)</sup>          | 0.14/0.07   | 0.14/0.07  | ns    |
| T <sub>ISDCK_D_DDR</sub> /T <sub>ISCKD_D_DDR</sub>             | D pin Setup/Hold with respect to CLK at DDR mode                                | 0.09/0.11   | 0.09/0.11  | ns    |
| T <sub>ISDCK_DDLY_DDR</sub> /T <sub>ISCKD_DDLY_DDR</sub>       | D pin Setup/Hold with respect to CLK at DDR mode (using IODELAY) <sup>(1)</sup> | 0.14/0.07   | 0.14/0.07  | ns    |
| Sequential Delays                                              |                                                                                 |             |            |       |
| T <sub>ISCKO_Q</sub>                                           | CLKDIV to out at Q pin                                                          | 0.75        | 0.75       | ns    |
| Propagation Delays                                             |                                                                                 |             |            |       |
| T <sub>ISDO_DO</sub>                                           | D input to DO output pin                                                        | 0.25        | 0.25       | ns    |

### Notes:

- Recorded at 0 tap value.
- $T_{ISCK\_CE2}$  and  $T_{ISCKC\_CE2}$  are reported as  $T_{ISCK\_CE}/T_{ISCKC\_CE}$  in a TRACE report.



## Output Serializer/Deserializer Switching Characteristics

Table 45: OSERDES Switching Characteristics

| Symbol                                                      | Description                                   | Speed Grade |            | Units |
|-------------------------------------------------------------|-----------------------------------------------|-------------|------------|-------|
|                                                             |                                               | -2          | -1         |       |
| Setup/Hold                                                  |                                               |             |            |       |
| T <sub>OSDCK_D</sub> /T <sub>OSCKD_D</sub>                  | D input Setup/Hold with respect to CLKDIV     | 0.31/−0.12  | 0.31/−0.12 | ns    |
| T <sub>OSDCK_T</sub> /T <sub>OSCKD_T</sub> <sup>(1)</sup>   | T input Setup/Hold with respect to CLK        | 0.56/−0.08  | 0.56/−0.08 | ns    |
| T <sub>OSDCK_T2</sub> /T <sub>OSCKD_T2</sub> <sup>(1)</sup> | T input Setup/Hold with respect to CLKDIV     | 0.31/−0.08  | 0.31/−0.08 | ns    |
| T <sub>OSCCK_OCE</sub> /T <sub>OSCKC_OCE</sub>              | OCE input Setup/Hold with respect to CLK      | 0.22/−0.05  | 0.22/−0.05 | ns    |
| T <sub>OSCCK_S</sub>                                        | SR (Reset) input Setup with respect to CLKDIV | 0.07        | 0.07       | ns    |
| T <sub>OSCCK_TCE</sub> /T <sub>OSCKC_TCE</sub>              | TCE input Setup/Hold with respect to CLK      | 0.21/−0.05  | 0.21/−0.05 | ns    |
| Sequential Delays                                           |                                               |             |            |       |
| T <sub>OSCKO_OQ</sub>                                       | Clock to out from CLK to OQ                   | 0.82        | 0.82       | ns    |
| T <sub>OSCKO_TQ</sub>                                       | Clock to out from CLK to TQ                   | 0.82        | 0.82       | ns    |
| Combinatorial                                               |                                               |             |            |       |
| T <sub>OSDO_TTQ</sub>                                       | T input to TQ Out                             | 0.97        | 0.97       | ns    |

### Notes:

- $T_{OSDCK\_T2}$  and  $T_{OSCKD\_T2}$  are reported as  $T_{OSDCK\_T}/T_{OSCKD\_T}$  in the TRACE report.

## Input/Output Delay Switching Characteristics

Table 46: Input/Output Delay Switching Characteristics

| Symbol                                            | Description                                                                            | Speed Grade                    |            | Units      |
|---------------------------------------------------|----------------------------------------------------------------------------------------|--------------------------------|------------|------------|
|                                                   |                                                                                        | -2                             | -1         |            |
| IDELAYCTRL                                        |                                                                                        |                                |            |            |
| T <sub>DLYCCO_RDY</sub>                           | Reset to Ready for IDELAYCTRL                                                          | 3                              | 3          | μs         |
| F <sub>IDELAYCTRL_REF</sub>                       | REFCLK frequency                                                                       | 200                            | 200        | MHz        |
| IDELAYCTRL_REF_PRECISION                          | REFCLK precision                                                                       | ±10                            | ±10        | MHz        |
| T <sub>IDELAYCTRL_RPW</sub>                       | Minimum Reset pulse width                                                              | 50                             | 50         | ns         |
| IODELAY                                           |                                                                                        |                                |            |            |
| T <sub>IDELAYRESOLUTION</sub>                     | IODELAY Chain Delay Resolution                                                         | 1/(32 x 2 x F <sub>REF</sub> ) |            | ps         |
| T <sub>IDELAYPAT_JIT</sub>                        | Pattern dependent period jitter in delay chain for clock pattern. <sup>(1)</sup>       | 0                              | 0          | ps per tap |
|                                                   | Pattern dependent period jitter in delay chain for random data pattern. <sup>(2)</sup> | ±5                             | ±5         | ps per tap |
|                                                   | Pattern dependent period jitter in delay chain for random data pattern. <sup>(3)</sup> | ±9                             | ±9         | ps per tap |
| T <sub>IODELAY_CLK_MAX</sub>                      | Maximum frequency of CLK input to IODELAY                                              | 300                            | 300        | MHz        |
| T <sub>IODCCK_CE</sub> / T <sub>IODCKC_CE</sub>   | CE pin Setup/Hold with respect to CK                                                   | 0.65/–0.09                     | 0.65/–0.09 | ns         |
| T <sub>IODCK_INC</sub> / T <sub>IODCKC_INC</sub>  | INC pin Setup/Hold with respect to CK                                                  | 0.31/–0.00                     | 0.31/–0.00 | ns         |
| T <sub>IODCCK_RST</sub> / T <sub>IODCKC_RST</sub> | RST pin Setup/Hold with respect to CK                                                  | 0.69/–0.08                     | 0.69/–0.08 | ns         |
| T <sub>IODDO_T</sub>                              | TSCONTROL delay to MUXE/MUXF switching and through IODELAY                             | Note 4                         | Note 4     | ps         |
| T <sub>IODDO_IDATAIN</sub>                        | Propagation delay through IODELAY                                                      | Note 4                         | Note 4     | ps         |
| T <sub>IODDO_ODATAIN</sub>                        | Propagation delay through IODELAY                                                      | Note 4                         | Note 4     | ps         |

### Notes:

1. When HIGH\_PERFORMANCE mode is set to TRUE or FALSE.
2. When HIGH\_PERFORMANCE mode is set to TRUE
3. When HIGH\_PERFORMANCE mode is set to FALSE.
4. Delay depends on IDELAY tap setting. See the TRACE report for actual values.

## CLB Switching Characteristics

Table 47: CLB Switching Characteristics

| Symbol               | Description                       | Speed Grade |      | Units   |
|----------------------|-----------------------------------|-------------|------|---------|
|                      |                                   | -2          | -1   |         |
| Combinatorial Delays |                                   |             |      |         |
| T <sub>ILO</sub>     | An – Dn LUT address to A          | 0.08        | 0.08 | ns, Max |
|                      | An – Dn LUT address to AMUX/CMUX  | 0.23        | 0.25 | ns, Max |
|                      | An – Dn LUT address to BMUX_A     | 0.37        | 0.41 | ns, Max |
| T <sub>ITO</sub>     | An – Dn inputs to A – D Q outputs | 0.79        | 0.91 | ns, Max |
| T <sub>AXA</sub>     | AX inputs to AMUX output          | 0.42        | 0.48 | ns, Max |
| T <sub>AXB</sub>     | AX inputs to BMUX output          | 0.47        | 0.53 | ns, Max |
| T <sub>AXC</sub>     | AX inputs to CMUX output          | 0.52        | 0.60 | ns, Max |
| T <sub>AXD</sub>     | AX inputs to DMUX output          | 0.55        | 0.63 | ns, Max |

Table 47: CLB Switching Characteristics (Cont'd)

| Symbol                                                               | Description                               | Speed Grade |            | Units   |
|----------------------------------------------------------------------|-------------------------------------------|-------------|------------|---------|
|                                                                      |                                           | -2          | -1         |         |
| $T_{BxB}$                                                            | BX inputs to BMUX output                  | 0.39        | 0.45       | ns, Max |
| $T_{BXD}$                                                            | BX inputs to DMUX output                  | 0.50        | 0.58       | ns, Max |
| $T_{CXB}$                                                            | CX inputs to CMUX output                  | 0.34        | 0.38       | ns, Max |
| $T_{CXD}$                                                            | CX inputs to DMUX output                  | 0.40        | 0.45       | ns, Max |
| $T_{DXD}$                                                            | DX inputs to DMUX output                  | 0.38        | 0.44       | ns, Max |
| $T_{OPCYA}$                                                          | An input to COUT output                   | 0.42        | 0.47       | ns, Max |
| $T_{OPCYB}$                                                          | Bn input to COUT output                   | 0.42        | 0.47       | ns, Max |
| $T_{OPCYC}$                                                          | Cn input to COUT output                   | 0.35        | 0.39       | ns, Max |
| $T_{OPCYD}$                                                          | Dn input to COUT output                   | 0.33        | 0.37       | ns, Max |
| $T_{AXCY}$                                                           | AX input to COUT output                   | 0.33        | 0.38       | ns, Max |
| $T_{BXCy}$                                                           | BX input to COUT output                   | 0.28        | 0.32       | ns, Max |
| $T_{CXCy}$                                                           | CX input to COUT output                   | 0.20        | 0.23       | ns, Max |
| $T_{DXCY}$                                                           | DX input to COUT output                   | 0.19        | 0.22       | ns, Max |
| $T_{BYP}$                                                            | CIN input to COUT output                  | 0.08        | 0.09       | ns, Max |
| $T_{CINA}$                                                           | CIN input to AMUX output                  | 0.28        | 0.32       | ns, Max |
| $T_{CINB}$                                                           | CIN input to BMUX output                  | 0.29        | 0.34       | ns, Max |
| $T_{CINC}$                                                           | CIN input to CMUX output                  | 0.30        | 0.34       | ns, Max |
| $T_{CIND}$                                                           | CIN input to DMUX output                  | 0.33        | 0.38       | ns, Max |
| <b>Sequential Delays</b>                                             |                                           |             |            |         |
| $T_{CKO}$                                                            | Clock to AQ – DQ outputs                  | 0.39        | 0.44       | ns, Max |
| $T_{SHCKO}$                                                          | Clock to AMUX – DMUX outputs              | 0.47        | 0.54       | ns, Max |
| <b>Setup and Hold Times of CLB Flip-Flops Before/After Clock CLK</b> |                                           |             |            |         |
| $T_{DICK}/T_{CKDI}$                                                  | A – D input to CLK on A – D Flip Flops    | 0.43/0.20   | 0.50/0.23  | ns, Min |
| $T_{CECK\_CLB}/T_{CKCE\_CLB}$                                        | CE input to CLK on A – D Flip Flops       | 0.32/–0.01  | 0.37/–0.01 | ns, Min |
| $T_{SRCK}/T_{CKSR}$                                                  | SR input to CLK on A – D Flip Flops       | 0.52/–0.08  | 0.60/–0.08 | ns, Min |
| $T_{CINCK}/T_{CKCIN}$                                                | CIN input to CLK on A – D Flip Flops      | 0.24/0.17   | 0.27/0.19  | ns, Min |
| <b>Set/Reset</b>                                                     |                                           |             |            |         |
| $T_{SRMIN}$                                                          | SR input minimum pulse width              | 0.97        | 0.97       | ns, Min |
| $T_{RQ}$                                                             | Delay from SR input to AQ – DQ flip-flops | 0.68        | 0.78       | ns, Max |
| $T_{CEO}$                                                            | Delay from CE input to AQ – DQ flip-flops | 0.59        | 0.67       | ns, Max |
| $F_{TOG}$                                                            | Toggle frequency (for export control)     | 1098.00     | 1098.00    | MHz     |

**Notes:**

1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.
2. These items are of interest for Carry Chain applications.

## CLB Distributed RAM Switching Characteristics (SLICEM Only)

Table 48: CLB Distributed RAM Switching Characteristics

| Symbol                                      | Description                  | Speed Grade |            | Units   |
|---------------------------------------------|------------------------------|-------------|------------|---------|
|                                             |                              | -2          | -1         |         |
| Sequential Delays                           |                              |             |            |         |
| T <sub>SHCKO</sub>                          | Clock to A – B outputs       | 1.36        | 1.56       | ns, Max |
| T <sub>SHCKO_1</sub>                        | Clock to AMUX – BMUX outputs | 1.71        | 1.96       | ns, Max |
| Setup and Hold Times Before/After Clock CLK |                              |             |            |         |
| T <sub>DS</sub> /T <sub>DH</sub>            | A – D inputs to CLK          | 0.88/0.22   | 1.01/0.26  | ns, Min |
| T <sub>AS</sub> /T <sub>AH</sub>            | Address An inputs to clock   | 0.27/0.70   | 0.31/0.80  | ns, Min |
| T <sub>WS</sub> /T <sub>WH</sub>            | WE input to clock            | 0.40/–0.01  | 0.46/0.00  | ns, Min |
| T <sub>CECK</sub> /T <sub>CKCE</sub>        | CE input to CLK              | 0.41/–0.02  | 0.48/–0.01 | ns, Min |
| Clock CLK                                   |                              |             |            |         |
| T <sub>MPW</sub>                            | Minimum pulse width          | 1.00        | 1.15       | ns, Min |
| T <sub>MCP</sub>                            | Minimum clock period         | 2.00        | 2.30       | ns, Min |

**Notes:**

1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values cannot be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.
2.  $T_{SHCKO}$  also represents the CLK to XMUX output. Refer to the TRACE report for the CLK to XMUX path.

## CLB Shift Register Switching Characteristics (SLICEM Only)

Table 49: CLB Shift Register Switching Characteristics

| Symbol                                      | Description                         | Speed Grade |            | Units   |
|---------------------------------------------|-------------------------------------|-------------|------------|---------|
|                                             |                                     | -2          | -1         |         |
| Sequential Delays                           |                                     |             |            |         |
| T <sub>REG</sub>                            | Clock to A – D outputs              | 1.58        | 1.82       | ns, Max |
| T <sub>REG_MUX</sub>                        | Clock to AMUX – DMUX output         | 1.93        | 2.22       | ns, Max |
| T <sub>REG_M31</sub>                        | Clock to DMUX output via M31 output | 1.55        | 1.78       | ns, Max |
| Setup and Hold Times Before/After Clock CLK |                                     |             |            |         |
| T <sub>WS</sub> /T <sub>WH</sub>            | WE input                            | 0.09/–0.01  | 0.10/0.00  | ns, Min |
| T <sub>CECK</sub> /T <sub>CKCE</sub>        | CE input to CLK                     | 0.10/–0.02  | 0.11/–0.01 | ns, Min |
| T <sub>DS</sub> /T <sub>DH</sub>            | A – D inputs to CLK                 | 0.94/0.24   | 1.08/0.28  | ns, Min |
| Clock CLK                                   |                                     |             |            |         |
| T <sub>MPW</sub>                            | Minimum pulse width                 | 0.85        | 0.98       | ns, Min |

**Notes:**

1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values cannot be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

## Block RAM and FIFO Switching Characteristics

Table 50: Block RAM and FIFO Switching Characteristics

| Symbol                                                            | Description                                                                    | Speed Grade |           | Units   |
|-------------------------------------------------------------------|--------------------------------------------------------------------------------|-------------|-----------|---------|
|                                                                   |                                                                                | -2          | -1        |         |
| Block RAM and FIFO Clock-to-Out Delays                            |                                                                                |             |           |         |
| T <sub>RCKO_DO</sub> and T <sub>RCKO_DO_REG</sub> <sup>(1)</sup>  | Clock CLK to DOUT output (without output register) <sup>(2)(3)</sup>           | 2.08        | 2.39      | ns, Max |
|                                                                   | Clock CLK to DOUT output (with output register) <sup>(4)(5)</sup>              | 0.75        | 0.86      | ns, Max |
| T <sub>RCKO_DO_ECC</sub> and T <sub>RCKO_DO_ECC_REG</sub>         | Clock CLK to DOUT output with ECC (without output register) <sup>(2)(3)</sup>  | 3.30        | 3.79      | ns, Max |
|                                                                   | Clock CLK to DOUT output with ECC (with output register) <sup>(4)(5)</sup>     | 0.86        | 0.98      | ns, Max |
| T <sub>RCKO_CASC</sub> and T <sub>RCKO_CASC_REG</sub>             | Clock CLK to DOUT output with Cascade (without output register) <sup>(2)</sup> | 3.18        | 3.65      | ns, Max |
|                                                                   | Clock CLK to DOUT output with Cascade (with output register) <sup>(4)</sup>    | 1.58        | 1.81      | ns, Max |
| T <sub>RCKO_FLAGS</sub>                                           | Clock CLK to FIFO flags outputs <sup>(6)</sup>                                 | 0.91        | 1.05      | ns, Max |
| T <sub>RCKO_POINTERS</sub>                                        | Clock CLK to FIFO pointers outputs <sup>(7)</sup>                              | 1.09        | 1.25      | ns, Max |
| T <sub>RCKO_RDCOUNT</sub>                                         | Clock CLK to FIFO Read Counter                                                 | 1.09        | 1.25      | ns, Max |
| T <sub>RCKO_WRCOUNT</sub>                                         | Clock CLK to FIFO Write Counter                                                | 1.09        | 1.25      | ns, Max |
| T <sub>RCKO_SDBIT_ECC</sub> and T <sub>RCKO_SDBIT_ECC_REG</sub>   | Clock CLK to BITERR (with output register)                                     | 0.76        | 0.87      | ns, Max |
|                                                                   | Clock CLK to BITERR (without output register)                                  | 2.84        | 3.26      | ns, Max |
| T <sub>RCKO_PARITY_ECC</sub>                                      | Clock CLK to ECCPARITY in ECC encode only mode                                 | 1.06        | 1.21      | ns, Max |
| T <sub>RCKO_RDADDR_ECC</sub> and T <sub>RCKO_RDADDR_ECC_REG</sub> | Clock CLK to RDADDR output with ECC (without output register)                  | 0.90        | 1.03      | ns, Max |
|                                                                   | Clock CLK to RDADDR output with ECC (with output register)                     | 0.92        | 1.06      | ns, Max |
| Setup and Hold Times Before/After Clock CLK                       |                                                                                |             |           |         |
| T <sub>RCCK_ADDR</sub> /T <sub>RCKC_ADDR</sub>                    | ADDR inputs <sup>(8)</sup>                                                     | 0.62/0.32   | 0.72/0.37 | ns, Min |
| T <sub>RDCK_DI</sub> /T <sub>RCKD_DI</sub>                        | DIN inputs <sup>(9)</sup>                                                      | 1.11/0.34   | 1.28/0.39 | ns, Min |
| T <sub>RDCK_DI_ECC</sub> /T <sub>RCKD_DI_ECC</sub>                | DIN inputs with block RAM ECC in standard mode <sup>(9)</sup>                  | 0.59/0.34   | 0.68/0.39 | ns, Min |
|                                                                   | DIN inputs with block RAM ECC encode only <sup>(9)</sup>                       | 0.85/0.34   | 0.97/0.39 | ns, Min |
|                                                                   | DIN inputs with FIFO ECC in standard mode <sup>(9)</sup>                       | 1.02/0.34   | 1.17/0.39 | ns, Min |
| T <sub>RCCK_CLK</sub> /T <sub>RCKC_CLK</sub>                      | Inject single/double bit error in ECC mode                                     | 1.20/0.29   | 1.38/0.33 | ns, Min |
| T <sub>RCCK_RDEN</sub> /T <sub>RCKC_RDEN</sub>                    | Block RAM Enable (EN) input                                                    | 0.41/0.30   | 0.47/0.34 | ns, Min |
| T <sub>RCCK_REGCE</sub> /T <sub>RCKC_REGCE</sub>                  | CE input of output register                                                    | 0.22/0.31   | 0.25/0.35 | ns, Min |
| T <sub>RCCK_RSTREG</sub> /T <sub>RCKC_RSTREG</sub>                | Synchronous RSTREG input                                                       | 0.28/0.26   | 0.32/0.29 | ns, Min |
| T <sub>RCCK_RSTRAM</sub> /T <sub>RCKC_RSTRAM</sub>                | Synchronous RSTRAM input                                                       | 0.41/0.27   | 0.47/0.31 | ns, Min |
| T <sub>RCCK_WE</sub> /T <sub>RCKC_WE</sub>                        | Write Enable (WE) input (block RAM only)                                       | 0.52/0.35   | 0.60/0.40 | ns, Min |
| T <sub>RCCK_WREN</sub> /T <sub>RCKC_WREN</sub>                    | WREN FIFO inputs                                                               | 0.55/0.30   | 0.64/0.34 | ns, Min |
| T <sub>RCCK_RDEN</sub> /T <sub>RCKC_RDEN</sub>                    | RDEN FIFO inputs                                                               | 0.55/0.30   | 0.63/0.34 | ns, Min |
| Reset Delays                                                      |                                                                                |             |           |         |
| T <sub>RCO_FLAGS</sub>                                            | Reset RST to FIFO Flags/Pointers <sup>(10)</sup>                               | 1.10        | 1.27      | ns, Max |
| T <sub>RCCK_RSTREG</sub> /T <sub>RCKC_RSTREG</sub>                | FIFO reset timing <sup>(11)</sup>                                              | 0.28/0.26   | 0.32/0.29 | ns, Min |

Table 50: Block RAM and FIFO Switching Characteristics (Cont'd)

| Symbol                   | Description                                         | Speed Grade |     | Units |
|--------------------------|-----------------------------------------------------|-------------|-----|-------|
|                          |                                                     | -2          | -1  |       |
| Maximum Frequency        |                                                     |             |     |       |
| F <sub>MAX</sub>         | Block RAM (Write First and No Change modes)         | 400         | 350 | MHz   |
|                          | Block RAM (Read First mode)                         | 400         | 347 | MHz   |
|                          | Block RAM (SDP mode) <sup>(12)</sup>                | 400         | 347 | MHz   |
| F <sub>MAX_CASCADE</sub> | Block RAM Cascade (Write First and No Change modes) | 400         | 347 | MHz   |
|                          | Block RAM Cascade (Read First mode)                 | 350         | 304 | MHz   |
| F <sub>MAX_FIFO</sub>    | FIFO in all modes                                   | 400         | 350 | MHz   |
| F <sub>MAX_ECC</sub>     | Block RAM and FIFO in ECC configuration             | 325         | 282 | MHz   |

**Notes:**

1. TRACE will report all of these parameters as  $T_{RCKO\_DO}$ .
2.  $T_{RCKO\_DOR}$  includes  $T_{RCKO\_DOW}$ ,  $T_{RCKO\_DOPR}$ , and  $T_{RCKO\_DOPW}$  as well as the B port equivalent timing parameters.
3. These parameters also apply to synchronous FIFO with  $DO\_REG = 0$ .
4.  $T_{RCKO\_DO}$  includes  $T_{RCKO\_DOP}$  as well as the B port equivalent timing parameters.
5. These parameters also apply to multirate (asynchronous) and synchronous FIFO with  $DO\_REG = 1$ .
6.  $T_{RCKO\_FLAGS}$  includes the following parameters:  $T_{RCKO\_AEMPTY}$ ,  $T_{RCKO\_AFULL}$ ,  $T_{RCKO\_EMPTY}$ ,  $T_{RCKO\_FULL}$ ,  $T_{RCKO\_RDERR}$ ,  $T_{RCKO\_WRERR}$ .
7.  $T_{RCKO\_POINTERS}$  includes both  $T_{RCKO\_RDCOUNT}$  and  $T_{RCKO\_WRCOUNT}$ .
8. The ADDR setup and hold must be met when EN is asserted (even when WE is deasserted). Otherwise, block RAM data corruption is possible.
9.  $T_{RCKO\_DI}$  includes both A and B inputs as well as the parity inputs of A and B.
10.  $T_{RCKO\_FLAGS}$  includes the following flags: AEMPTY, AFULL, EMPTY, FULL, RDERR, WRERR, RDCOUNT, and WRCOUNT.
11. The FIFO reset must be asserted for at least three positive clock edges.
12. When using ISE software v12.4 or later, if the  $RDARRDR\_COLLISION\_HWCONFIG$  attribute is set to PERFORMANCE or the block RAM is in single-port operation, then the faster  $F_{MAX}$  for WRITE\_FIRST/NO\_CHANGE modes apply.

## DSP48E1 Switching Characteristics

Table 51: DSP48E1 Switching Characteristics

| Symbol                                                                                            | Description                                                     | Speed Grade |            | Units |
|---------------------------------------------------------------------------------------------------|-----------------------------------------------------------------|-------------|------------|-------|
|                                                                                                   |                                                                 | -2          | -1         |       |
| Setup and Hold Times of Data/Control Pins to the Input Register Clock                             |                                                                 |             |            |       |
| $T_{DSPDCK\_A, ACIN; B, BCIN\_AREG; BREG}/T_{DSPCKD\_A, ACIN; B, BCIN\_AREG; BREG}$               | {A, ACIN, B, BCIN} input to {A, B} register CLK                 | 0.35/0.34   | 0.41/0.39  | ns    |
| $T_{DSPDCK\_C\_CREG}/T_{DSPCKD\_C\_CREG}$                                                         | C input to C register CLK                                       | 0.22/0.24   | 0.26/0.27  | ns    |
| $T_{DSPDCK\_D\_DREG}/T_{DSPCKD\_D\_DREG}$                                                         | D input to D register CLK                                       | 0.15/0.39   | 0.17/0.44  | ns    |
| Setup and Hold Times of Data Pins to the Pipeline Register Clock                                  |                                                                 |             |            |       |
| $T_{DSPDCK\_A, ACIN, B, BCIN\_PREG\_MULT}/T_{DSPCKD\_A, ACIN, B, BCIN\_PREG\_MULT}$               | {A, ACIN, B, BCIN} input to M register CLK                      | 3.21/0.02   | 3.69/0.02  | ns    |
| $T_{DSPDCK\_A, D\_ADREG}/T_{DSPCKD\_A, D\_ADREG}$                                                 | {A, D} input to AD register CLK                                 | 1.69/0.13   | 1.94/0.15  | ns    |
| Setup and Hold Times of Data/Control Pins to the Output Register Clock                            |                                                                 |             |            |       |
| $T_{DSPDCK\_A, ACIN, B, BCIN\_PREG\_MULT}/T_{DSPCKD\_A, ACIN, B, BCIN\_PREG\_MULT}$               | {A, ACIN, B, BCIN} input to P register CLK using multiplier     | 5.20/−0.19  | 5.97/−0.22 | ns    |
| $T_{DSPDCK\_D\_DREG\_MULT}/T_{DSPCKD\_D\_DREG\_MULT}$                                             | D input to P register CLK                                       | 4.90/−0.65  | 5.63/−0.75 | ns    |
| $T_{DSPDCK\_A, ACIN, B, BCIN\_PREG}/T_{DSPCKD\_A, ACIN, B, BCIN\_PREG}$                           | {A, ACIN, B, BCIN} input to P register CLK not using multiplier | 2.15/−0.19  | 2.47/−0.22 | ns    |
| $T_{DSPDCK\_C\_PREG}/T_{DSPCKD\_C\_PREG}$                                                         | C input to P register CLK                                       | 1.91/−0.14  | 2.19/−0.17 | ns    |
| $T_{DSPDCK\_PCIN, CARRYCASCIN, MULTSIGNIN\_PREG}/T_{DSPCKD\_PCIN, CARRYCASCIN, MULTSIGNIN\_PREG}$ | {PCIN, CARRYCASCIN, MULTSIGNIN} input to P register CLK         | 1.67/−0.04  | 1.92/−0.05 | ns    |
| Setup and Hold Times of the CE Pins                                                               |                                                                 |             |            |       |
| $T_{DSPDCK\_CEA; CEB\_AREG; BREG}/T_{DSPCKD\_CEA; CEB\_AREG; BREG}$                               | {CEA, CEB} input to {A, B} register CLK                         | 0.22/0.25   | 0.25/0.29  | ns    |
| $T_{DSPDCK\_CEC\_CREG}/T_{DSPCKD\_CEC\_CREG}$                                                     | CEC input to C register CLK                                     | 0.24/0.23   | 0.28/0.27  | ns    |
| $T_{DSPDCK\_CED\_DREG}/T_{DSPCKD\_CED\_DREG}$                                                     | CED input to D register CLK                                     | 0.31/0.14   | 0.35/0.16  | ns    |
| $T_{DSPDCK\_CEM\_MREG}/T_{DSPCKD\_CEM\_MREG}$                                                     | CEM input to M register CLK                                     | 0.26/0.25   | 0.30/0.28  | ns    |
| $T_{DSPDCK\_CEP\_PREG}/T_{DSPCKD\_CEP\_PREG}$                                                     | CEP input to P register CLK                                     | 0.46/0.03   | 0.53/0.03  | ns    |
| Setup and Hold Times of the RST Pins                                                              |                                                                 |             |            |       |
| $T_{DSPDCK\_RSTA; RSTB\_AREG; BREG}/T_{DSPCKD\_RSTA; RSTB\_AREG; BREG}$                           | {RSTA, RSTB} input to {A, B} register CLK                       | 0.38/0.22   | 0.43/0.25  | ns    |
| $T_{DSPDCK\_RSTC\_CREG}/T_{DSPCKD\_RSTC\_CREG}$                                                   | RSTC input to C register CLK                                    | 0.23/0.09   | 0.27/0.11  | ns    |
| $T_{DSPDCK\_RSTD\_DREG}/T_{DSPCKD\_RSTD\_DREG}$                                                   | RSTD input to D register CLK                                    | 0.38/0.19   | 0.44/0.21  | ns    |
| $T_{DSPDCK\_RSTM\_MREG}/T_{DSPCKD\_RSTM\_MREG}$                                                   | RSTM input to M register CLK                                    | 0.26/0.30   | 0.30/0.35  | ns    |
| $T_{DSPDCK\_RSTP\_PREG}/T_{DSPCKD\_RSTP\_PREG}$                                                   | RSTP input to P register CLK                                    | 0.33/0.05   | 0.41/0.06  | ns    |
| Combinatorial Delays from Input Pins to Output Pins                                               |                                                                 |             |            |       |
| $T_{DSPDO\_A, B\_P, CARRYOUT\_MULT}$                                                              | {A, B} input to {P, CARRYOUT} output using multiplier           | 5.08        | 5.84       | ns    |
| $T_{DSPDO\_D\_P, CARRYOUT\_MULT}$                                                                 | D input to {P, CARRYOUT} output using multiplier                | 4.82        | 5.54       | ns    |
| $T_{DSPDO\_A, B\_P, CARRYOUT}$                                                                    | {A, B} input to {P, CARRYOUT} output not using multiplier       | 2.07        | 2.38       | ns    |
| $T_{DSPDO\_C, CARRYIN\_P, CARRYOUT}$                                                              | {C, CARRYIN} input to {P, CARRYOUT} output                      | 1.83        | 2.10       | ns    |

Table 51: DSP48E1 Switching Characteristics (Cont'd)

| Symbol                                                                                | Description                                                                          | Speed Grade |      | Units |
|---------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|-------------|------|-------|
|                                                                                       |                                                                                      | -2          | -1   |       |
| Combinatorial Delays from Input Pins to Cascading Output Pins                         |                                                                                      |             |      |       |
| T <sub>DSPDO_{A; B}_{ACOUT; BCOUT}</sub>                                              | {A, B} input to {ACOUT, BCOUT} output                                                | 0.65        | 0.75 | ns    |
| T <sub>DSPDO_{A, B}_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_MULT</sub>                     | {A, B} input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output using multiplier           | 5.24        | 6.03 | ns    |
| T <sub>DSPDO_D_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_MULT</sub>                          | D input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output using multiplier                | 4.94        | 5.68 | ns    |
| T <sub>DSPDO_{A, B}_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}</sub>                          | {A, B} input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output not using multiplier       | 2.19        | 2.52 | ns    |
| T <sub>DSPDO_{C, CARRYIN}_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}</sub>                    | {C, CARRYIN} input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output                      | 1.95        | 2.25 | ns    |
| Combinatorial Delays from Cascading Input Pins to All Output Pins                     |                                                                                      |             |      |       |
| T <sub>DSPDO_{ACIN, BCIN}_{P, CARRYOUT}_MULT</sub>                                    | {ACIN, BCIN} input to {P, CARRYOUT} output using multiplier                          | 4.97        | 5.72 | ns    |
| T <sub>DSPDO_{ACIN, BCIN}_{P, CARRYOUT}</sub>                                         | {ACIN, BCIN} input to {P, CARRYOUT} output not using multiplier                      | 1.92        | 2.21 | ns    |
| T <sub>DSPDO_{ACIN; BCIN}_{ACOUT; BCOUT}</sub>                                        | {ACIN, BCIN} input to {ACOUT, BCOUT} output                                          | 0.49        | 0.57 | ns    |
| T <sub>DSPDO_{ACIN, BCIN}_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_MULT</sub>               | {ACIN, BCIN} input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output using multiplier     | 5.10        | 5.86 | ns    |
| T <sub>DSPDO_{ACIN, BCIN}_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}</sub>                    | {ACIN, BCIN} input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output not using multiplier | 2.05        | 2.35 | ns    |
| T <sub>DSPDO_{PCIN, CARRYCASCIN, MULTSIGNIN}_{P, CARRYOUT}</sub>                      | {PCIN, CARRYCASCIN, MULTSIGNIN} input to {P, CARRYOUT} output                        | 1.60        | 1.83 | ns    |
| T <sub>DSPDO_{PCIN, CARRYCASCIN, MULTSIGNIN}_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}</sub> | {PCIN, CARRYCASCIN, MULTSIGNIN} input to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output   | 1.72        | 1.98 | ns    |
| Clock to Outs from Output Register Clock to Output Pins                               |                                                                                      |             |      |       |
| T <sub>DSPCKO_{P, CARRYOUT}_PREG</sub>                                                | CLK (PREG) to {P, CARRYOUT} output                                                   | 0.50        | 0.57 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_PREG</sub>                           | CLK (PREG) to {CARRYCASCOUT, PCOUT, MULTSIGNOUT} output                              | 0.50        | 0.66 | ns    |
| Clock to Outs from Pipeline Register Clock to Output Pins                             |                                                                                      |             |      |       |
| T <sub>DSPCKO_{P, CARRYOUT}_MREG</sub>                                                | CLK (MREG) to {P, CARRYOUT} output                                                   | 2.30        | 2.65 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_MREG</sub>                           | CLK (MREG) to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output                              | 2.43        | 2.79 | ns    |
| T <sub>DSPCKO_{P, CARRYOUT}_ADREG_MULT</sub>                                          | CLK (ADREG) to {P, CARRYOUT} output                                                  | 3.72        | 4.72 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_ADREG_MULT</sub>                     | CLK (ADREG) to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output                             | 3.84        | 4.42 | ns    |
| Clock to Outs from Input Register Clock to Output Pins                                |                                                                                      |             |      |       |
| T <sub>DSPCKO_{P, CARRYOUT}_{AREG, BREG}_MULT</sub>                                   | CLK (AREG, BREG) to {P, CARRYOUT} output using multiplier                            | 5.36        | 6.16 | ns    |
| T <sub>DSPCKO_{P, CARRYOUT}_{AREG, BREG}</sub>                                        | CLK (AREG, BREG) to {P, CARRYOUT} output not using multiplier                        | 2.27        | 2.61 | ns    |
| T <sub>DSPCKO_{P, CARRYOUT}_CREG</sub>                                                | CLK (CREG) to {P, CARRYOUT} output                                                   | 2.27        | 2.61 | ns    |
| T <sub>DSPCKO_{P, CARRYOUT}_DREG_MULT</sub>                                           | CLK (DREG) to {P, CARRYOUT} output                                                   | 5.25        | 6.04 | ns    |



Table 51: DSP48E1 Switching Characteristics (Cont'd)

| Symbol                                                                   | Description                                                                        | Speed Grade |      | Units |
|--------------------------------------------------------------------------|------------------------------------------------------------------------------------|-------------|------|-------|
|                                                                          |                                                                                    | -2          | -1   |       |
| Clock to Outs from Input Register Clock to Cascading Output Pins         |                                                                                    |             |      |       |
| T <sub>DSPCKO_{ACOUT; BCOUT}_{AREG; BREG}</sub>                          | CLK (AREG, BREG) to {P, CARRYOUT} output                                           | 0.89        | 1.02 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_{AREG, BREG}_MULT</sub> | CLK (AREG, BREG) to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output using multiplier     | 5.49        | 6.31 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_{AREG, BREG}</sub>      | CLK (AREG, BREG) to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output not using multiplier | 2.40        | 2.76 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_DREG_MULT</sub>         | CLK (DREG) to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output using multiplier           | 5.38        | 6.18 | ns    |
| T <sub>DSPCKO_{PCOUT, CARRYCASCOUT, MULTSIGNOUT}_CREG</sub>              | CLK (CREG) to {PCOUT, CARRYCASCOUT, MULTSIGNOUT} output                            | 2.40        | 2.76 | ns    |
| Maximum Frequency                                                        |                                                                                    |             |      |       |
| F <sub>MAX</sub>                                                         | With all registers used                                                            | 350         | 275  | MHz   |
| F <sub>MAX_PATDET</sub>                                                  | With pattern detector                                                              | 350         | 275  | MHz   |
| F <sub>MAX_MULT_NOMREG</sub>                                             | Two register multiply without MREG                                                 | 262         | 227  | MHz   |
| F <sub>MAX_MULT_NOMREG_PATDET</sub>                                      | Two register multiply without MREG with pattern detect                             | 241         | 209  | MHz   |
| F <sub>MAX_PREADD_MULT_NOADREG</sub>                                     | Without ADREG                                                                      | 292         | 253  | MHz   |
| F <sub>MAX_PREADD_MULT_NOADREG_PATDET</sub>                              | Without ADREG with pattern detect                                                  | 292         | 253  | MHz   |
| F <sub>MAX_NOPIELINEREG</sub>                                            | Without pipeline registers (MREG, ADREG)                                           | 196         | 170  | MHz   |
| F <sub>MAX_NOPIELINEREG_PATDET</sub>                                     | Without pipeline registers (MREG, ADREG) with pattern detect                       | 184         | 160  | MHz   |

# Configuration Switching Characteristics

Table 52: Configuration Switching Characteristics

| Symbol                                                        | Description                                                                                                                               | Speed Grade |          | Units       |
|---------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------|-------------|----------|-------------|
|                                                               |                                                                                                                                           | -2          | -1       |             |
| Power-up Timing Characteristics                               |                                                                                                                                           |             |          |             |
| T <sub>PL</sub> <sup>(1)</sup>                                | Program Latency                                                                                                                           | 3           | 3        | ms, Max     |
| T <sub>POR</sub> <sup>(1)</sup>                               | Power-on-Reset                                                                                                                            | 15/55       | 15/55    | ms, Min/Max |
| T <sub>ICCK</sub>                                             | CCLK (output) delay                                                                                                                       | 400         | 400      | ns, Min     |
| T <sub>PROGRAM</sub>                                          | Program Pulse Width                                                                                                                       | 250         | 250      | ns, Min     |
| Master/Slave Serial Mode Programming Switching <sup>(1)</sup> |                                                                                                                                           |             |          |             |
| T <sub>DCCK</sub> /T <sub>CCKD</sub>                          | DIN Setup/Hold, slave mode                                                                                                                | 4.0/0.0     | 4.0/0.0  | ns, Min     |
| T <sub>DSCCK</sub> /T <sub>SCCKD</sub>                        | DIN Setup/Hold, master mode                                                                                                               | 4.0/0.0     | 4.0/0.0  | ns, Min     |
| T <sub>CCO</sub>                                              | DOOUT at 2.5V                                                                                                                             | 6           | 6        | ns, Max     |
|                                                               | DOOUT at 1.8V                                                                                                                             | 6           | 6        | ns, Max     |
| F <sub>MCCK</sub>                                             | Maximum CCLK frequency, serial modes                                                                                                      | 100         | 100      | MHz, Max    |
| F <sub>MCCKTOL</sub>                                          | Frequency Tolerance, master mode with respect to nominal CCLK                                                                             | 55          | 55       | %           |
| F <sub>MSCCK</sub>                                            | Slave mode external CCLK                                                                                                                  | 100         | 100      | MHz         |
| SelectMAP Mode Programming Switching                          |                                                                                                                                           |             |          |             |
| T <sub>SMDCCK</sub> /T <sub>SMCCKD</sub>                      | SelectMAP Data Setup/Hold                                                                                                                 | 4.0/0.0     | 4.0/0.0  | ns, Min     |
| T <sub>SMCSCCK</sub> /T <sub>SMCCKCS</sub>                    | CSI_B Setup/Hold                                                                                                                          | 4.0/0.0     | 4.0/0.0  | ns, Min     |
| T <sub>SMCCKW</sub> /T <sub>SMWCKK</sub>                      | RDWR_B Setup/Hold                                                                                                                         | 10.0/0.0    | 10.0/0.0 | ns, Min     |
| T <sub>SMCKCSO</sub>                                          | CSO_B clock to out<br>(330 Ω pull-up resistor required)                                                                                   | 7           | 7        | ns, Min     |
| T <sub>SMCO</sub>                                             | CCLK to DATA out in readback at 2.5V                                                                                                      | 8           | 8        | ns, Max     |
|                                                               | CCLK to DATA out in readback at 1.8V                                                                                                      | 8           | 8        | ns, Max     |
| T <sub>SMCKBY</sub>                                           | CCLK to BUSY out in readback at 2.5V                                                                                                      | 6           | 6        | ns, Max     |
|                                                               | CCLK to BUSY out in readback at 1.8V                                                                                                      | 6           | 6        | ns, Max     |
| F <sub>SMCCK</sub>                                            | Maximum Frequency with respect to nominal CCLK                                                                                            | 100         | 100      | MHz, Max    |
| F <sub>RBCKK</sub>                                            | Maximum Readback Frequency with respect to nominal CCLK                                                                                   | 100         | 100      | MHz, Max    |
| F <sub>MCCKTOL</sub>                                          | Frequency Tolerance with respect to nominal CCLK                                                                                          | 55          | 55       | %           |
| Boundary-Scan Port Timing Specifications                      |                                                                                                                                           |             |          |             |
| T <sub>TAPTCK</sub> /T <sub>TCKTAP</sub>                      | TMS and TDI Setup time before TCK/ Hold time after TCK                                                                                    | 3.0/2.0     | 3.0/2.0  | ns, Min     |
| T <sub>TCKTDO</sub>                                           | TCK falling edge to TDO output valid at 2.5V                                                                                              | 6           | 6        | ns, Max     |
|                                                               | TCK falling edge to TDO output valid at 1.8V                                                                                              | 6           | 6        | ns, Max     |
| F <sub>TCK</sub>                                              | Maximum configuration TCK clock frequency                                                                                                 | 66          | 66       | MHz, Max    |
| F <sub>TCKB_MIN</sub>                                         | Minimum boundary-scan TCK clock frequency when using IEEE Std 1149.6 (AC-JTAG). Minimum operating temperature for IEEE Std 1149.6 is 0°C. | 15          | 15       | MHz, Min    |
| F <sub>TCKB</sub>                                             | Maximum boundary-scan TCK clock frequency                                                                                                 | 66          | 66       | MHz, Max    |

Table 52: Configuration Switching Characteristics (Cont'd)

| Symbol                                                            | Description                                                                           | Speed Grade |           | Units       |
|-------------------------------------------------------------------|---------------------------------------------------------------------------------------|-------------|-----------|-------------|
|                                                                   |                                                                                       | -2          | -1        |             |
| BPI Master Flash Mode Programming Switching                       |                                                                                       |             |           |             |
| T <sub>BPICCO</sub> <sup>(2)</sup>                                | ADDR[25:0], RS[1:0], FCS_B, FOE_B, FWE_B outputs valid after CCLK rising edge at 2.5V | 6           | 6         | ns          |
|                                                                   | ADDR[25:0], RS[1:0], FCS_B, FOE_B, FWE_B outputs valid after CCLK rising edge at 1.8V | 6           | 6         | ns          |
| T <sub>BPIDCC</sub> /T <sub>BPICCD</sub>                          | Setup/Hold on D[15:0] data input pins                                                 | 4.0/0.0     | 4.0/0.0   | ns          |
| T <sub>INITADDR</sub>                                             | Minimum period of initial ADDR[25:0] address cycles                                   | 3           | 3         | CCLK cycles |
| SPI Master Flash Mode Programming Switching                       |                                                                                       |             |           |             |
| T <sub>SPIDCC</sub> /T <sub>SPIDCCD</sub>                         | DIN Setup/Hold before/after the rising CCLK edge                                      | 3.0/0.0     | 3.0/0.0   | ns          |
| T <sub>SPICCM</sub>                                               | MOSI clock to out at 2.5V                                                             | 6           | 6         | ns          |
|                                                                   | MOSI clock to out at 1.8V                                                             | 6           | 6         | ns          |
| T <sub>SPICCF</sub>                                               | FCS_B clock to out at 2.5V                                                            | 6           | 6         | ns          |
|                                                                   | FCS_B clock to out at 1.8V                                                            | 6           | 6         | ns          |
| T <sub>FSINIT</sub> /T <sub>FSINITH</sub>                         | FS[2:0] to INIT_B rising edge Setup and Hold                                          | 2           | 2         | μs          |
| CCLK Output (Master Modes)                                        |                                                                                       |             |           |             |
| T <sub>MCCKL</sub>                                                | Master CCLK clock Low time duty cycle                                                 | 45/55       | 45/55     | %, Min/Max  |
| T <sub>MCCKH</sub>                                                | Master CCLK clock High time duty cycle                                                | 45/55       | 45/55     | %, Min/Max  |
| CCLK Input (Slave Modes)                                          |                                                                                       |             |           |             |
| T <sub>SCCKL</sub>                                                | Slave CCLK clock minimum Low time                                                     | 2.5         | 2.5       | ns, Min     |
| T <sub>SCCKH</sub>                                                | Slave CCLK clock minimum High time                                                    | 2.5         | 2.5       | ns, Min     |
| Dynamic Reconfiguration Port (DRP) for MMCM Before and After DCLK |                                                                                       |             |           |             |
| F <sub>DCK</sub>                                                  | Maximum frequency for DCLK                                                            | 200         | 200       | MHz         |
| T <sub>MMCMDCK_DADDR</sub> /<br>T <sub>MMCMCKD_DADDR</sub>        | DADDR Setup/Hold                                                                      | 1.63/0.00   | 1.63/0.00 | ns          |
| T <sub>MMCMDCK_DI</sub> /T <sub>MMCMCKD_DI</sub>                  | DI Setup/Hold                                                                         | 1.63/0.00   | 1.63/0.00 | ns          |
| T <sub>MMCMDCK_DEN</sub> /T <sub>MMCMCKD_DEN</sub>                | DEN Setup/Hold time                                                                   | 1.63/0.00   | 1.63/0.00 | ns          |
| T <sub>MMCMDCK_DWE</sub> /T <sub>MMCMCKD_DWE</sub>                | DWE Setup/Hold time                                                                   | 1.63/0.00   | 1.63/0.00 | ns          |
| T <sub>MMCMCKO_DO</sub>                                           | CLK to out of DO <sup>(3)</sup>                                                       | 3.64        | 3.64      | ns          |
| T <sub>MMCMCKO_DRDY</sub>                                         | CLK to out of DRDY                                                                    | 0.38        | 0.38      | ns          |

**Notes:**

1. To support longer delays in configuration, use the design solutions described in *Virtex-6 FPGA Configuration Guide*.
2. Only during configuration, the last edge is determined by a weak pull-up/pull-down resistor in the I/O.
3. DO will hold until next DRP operation.

## Clock Buffers and Networks

Table 53: Global Clock Switching Characteristics (Including BUFGCTRL)

| Symbol                              | Description                    | Speed Grade |           | Units |
|-------------------------------------|--------------------------------|-------------|-----------|-------|
|                                     |                                | -2          | -1        |       |
| $T_{BCCCK\_CE}/T_{BCKKC\_CE}^{(1)}$ | CE pins Setup/Hold             | 0.16/0.00   | 0.16/0.00 | ns    |
| $T_{BCCCK\_S}/T_{BCKKC\_S}^{(1)}$   | S pins Setup/Hold              | 0.16/0.00   | 0.16/0.00 | ns    |
| $T_{BCKKO\_O}^{(2)}$                | BUFGCTRL delay from I0/I1 to O | 0.10        | 0.10      | ns    |
| <b>Maximum Frequency</b>            |                                |             |           |       |
| $F_{MAX}$                           | Global clock tree (BUFG)       | 700         | 700       | MHz   |

**Notes:**

1.  $T_{BCCCK\_CE}$  and  $T_{BCKKC\_CE}$  must be satisfied to assure glitch-free operation of the global clock when switching between clocks. These parameters do not apply to the BUFGMUX\_VIRTEX4 primitive that assures glitch-free operation. The other global clock setup and hold times are optional; only needing to be satisfied if device operation requires simulation matches on a cycle-for-cycle basis when switching between clocks.
2.  $T_{BCKKO\_O}$  (BUFG delay from I0 to O) values are the same as  $T_{BCKKO\_O}$  values.

Table 54: Input/Output Clock Switching Characteristics (BUFIO)

| Symbol                   | Description                    | Speed Grade |      | Units |
|--------------------------|--------------------------------|-------------|------|-------|
|                          |                                | -2          | -1   |       |
| $T_{BIOCKO\_O}$          | Clock to out delay from I to O | 0.18        | 0.18 | ns    |
| <b>Maximum Frequency</b> |                                |             |      |       |
| $F_{MAX}$                | I/O clock tree (BUFIO)         | 710         | 710  | MHz   |

Table 55: Regional Clock Switching Characteristics (BUFR)

| Symbol                   | Description                                                     | Speed Grade |      | Units |
|--------------------------|-----------------------------------------------------------------|-------------|------|-------|
|                          |                                                                 | -2          | -1   |       |
| $T_{BRCKO\_O}$           | Clock to out delay from I to O                                  | 0.75        | 0.75 | ns    |
|                          |                                                                 | 0.75        | 0.75 | ns    |
|                          |                                                                 | 0.75        | 0.75 | ns    |
|                          |                                                                 | 0.75        | 0.75 | ns    |
| $T_{BRCKO\_O\_BYP}$      | Clock to out delay from I to O with Divide Bypass attribute set | 0.37        | 0.37 | ns    |
|                          |                                                                 | 0.37        | 0.37 | ns    |
|                          |                                                                 | 0.37        | 0.37 | ns    |
|                          |                                                                 | 0.37        | 0.37 | ns    |
| $T_{BRDO\_O}$            | Propagation delay from CLR to O                                 | 0.83        | 0.83 | ns    |
| <b>Maximum Frequency</b> |                                                                 |             |      |       |
| $F_{MAX}$                | Regional clock tree (BUFR)                                      | 300         | 300  | MHz   |

Table 56: Horizontal Clock Buffer Switching Characteristics (BUFH)

| Symbol                      | Description                    | Speed Grade |           | Units |
|-----------------------------|--------------------------------|-------------|-----------|-------|
|                             |                                | -2          | -1        |       |
| $T_{BHCKO\_O}$              | BUFH delay from I to O         | 0.13        | 0.13      | ns    |
| $T_{BHCK\_CE}/T_{BHCK\_CE}$ | CE pin Setup and Hold          | 0.05/0.05   | 0.05/0.05 | ns    |
| <b>Maximum Frequency</b>    |                                |             |           |       |
| $F_{MAX}$                   | Horizontal clock buffer (BUFH) | 700         | 700       | MHz   |

## MMCM Switching Characteristics

Table 57: MMCM Specification

| Symbol           | Description                                   | Speed Grade                             |      | Units |
|------------------|-----------------------------------------------|-----------------------------------------|------|-------|
|                  |                                               | -2                                      | -1   |       |
| $F_{INMAX}$      | Maximum Input Clock Frequency <sup>(1)</sup>  | 700                                     | 700  | MHz   |
| $F_{INMIN}$      | Minimum Input Clock Frequency                 | 10                                      | 10   | MHz   |
| $F_{INJITTER}$   | Maximum Input Clock Period Jitter             | < 20% of clock input period or 1 ns Max |      |       |
| $F_{INDUTY}$     | Allowable Input Duty Cycle: 10—49 MHz         | 25/75                                   |      | %     |
|                  | Allowable Input Duty Cycle: 50—199 MHz        | 30/70                                   |      | %     |
|                  | Allowable Input Duty Cycle: 200—399 MHz       | 35/65                                   |      | %     |
|                  | Allowable Input Duty Cycle: 400—499 MHz       | 40/60                                   |      | %     |
|                  | Allowable Input Duty Cycle: >500 MHz          | 45/55                                   |      | %     |
| $F_{MIN\_PSCLK}$ | Minimum Dynamic Phase Shift Clock Frequency   | 0.01                                    | 0.01 | MHz   |
| $F_{MAX\_PSCLK}$ | Maximum Dynamic Phase Shift Clock Frequency   | 450                                     | 450  | MHz   |
| $F_{VCOMIN}$     | Minimum MMCM VCO Frequency                    | 600                                     | 600  | MHz   |
| $F_{VCOMAX}$     | Maximum MMCM VCO Frequency                    | 1200                                    | 1200 | MHz   |
| $F_{BANDWIDTH}$  | Low MMCM Bandwidth at Typical <sup>(2)</sup>  | 1.00                                    | 1.00 | MHz   |
|                  | High MMCM Bandwidth at Typical <sup>(2)</sup> | 4.00                                    | 4.00 | MHz   |

Table 57: MMCM Specification (Cont'd)

| Symbol                                              | Description                                                                                              | Speed Grade                             |           | Units |
|-----------------------------------------------------|----------------------------------------------------------------------------------------------------------|-----------------------------------------|-----------|-------|
|                                                     |                                                                                                          | -2                                      | -1        |       |
| $T_{STATPHAOFFSET}$                                 | Static Phase Offset of the MMCM Outputs <sup>(3)</sup>                                                   | 0.12                                    | 0.12      | ns    |
| $T_{OUTJITTER}$                                     | MMCM Output Jitter <sup>(4)</sup>                                                                        | Note 1                                  |           |       |
| $T_{OUTDUTY}$                                       | MMCM Output Clock Duty Cycle Precision <sup>(5)</sup>                                                    | 0.20                                    | 0.20      | ns    |
| $T_{LOCKMAX}$                                       | MMCM Maximum Lock Time                                                                                   | 100                                     | 100       | μs    |
| $F_{OUTMAX}$                                        | MMCM Maximum Output Frequency                                                                            | 700                                     | 700       | MHz   |
| $F_{OUTMIN}$                                        | MMCM Minimum Output Frequency <sup>(6)(7)</sup>                                                          | 4.69                                    | 4.69      | MHz   |
| $T_{EXTFDVAR}$                                      | External Clock Feedback Variation                                                                        | < 20% of clock input period or 1 ns Max |           |       |
| $RST_{MINPULSE}$                                    | Minimum Reset Pulse Width                                                                                | 1.5                                     | 1.5       | ns    |
| $F_{PFDMAX}$                                        | Maximum Frequency at the Phase Frequency Detector with Bandwidth Set to High or Optimized <sup>(8)</sup> | 450                                     | 450       | MHz   |
|                                                     | Maximum Frequency at the Phase Frequency Detector with Bandwidth Set to Low                              | 300                                     | 300       | MHz   |
| $F_{PFDMIN}$                                        | Minimum Frequency at the Phase Frequency Detector with Bandwidth Set to High or Optimized                | 135                                     | 135       | MHz   |
|                                                     | Minimum Frequency at the Phase Frequency Detector with Bandwidth Set to Low                              | 10.00                                   | 10.00     | MHz   |
| $T_{FBDELAY}$                                       | Maximum Delay in the Feedback Path                                                                       | 3 ns Max or one CLKIN cycle             |           |       |
| $T_{MMCMCKD\_PSEN}/$<br>$T_{MMCMCKD\_PSEN}$         | Setup and Hold of Phase Shift Enable                                                                     | 1.04/0.00                               | 1.04/0.00 | ns    |
| $T_{MMCMCKD\_PSINCDEC}/$<br>$T_{MMCMCKD\_PSINCDEC}$ | Setup and Hold of Phase Shift Increment/Decrement                                                        | 1.04/0.00                               | 1.04/0.00 | ns    |
| $T_{MMCMCKO\_PSDONE}$                               | Phase Shift Clock-to-Out of PSDONE                                                                       | 0.38                                    | 0.38      | ns    |

**Notes:**

1. When  $DIVCLK\_DIVIDE = 3$  or  $4$ ,  $F_{INMAX}$  is 315 MHz.
2. The MMCM does not filter typical spread-spectrum input clocks because they are usually far below the bandwidth filter frequencies.
3. The static offset is measured between any MMCM outputs with identical phase.
4. Values for this parameter are available in the Architecture Wizard.
5. Includes global clock buffer.
6. Calculated as  $F_{VCO}/128$  assuming output duty cycle is 50%.
7. When  $CASCADE4\_OUT = TRUE$ ,  $F_{OUTMIN}$  is 0.036 MHz.
8. In ISE software 12.3 (or earlier versions supporting the Virtex-6 family), the phase frequency detector Optimized bandwidth setting is equivalent to the High bandwidth setting. Starting with ISE software 12.4, the Optimized bandwidth setting is automatically adjusted to Low when the software can determine that the phase frequency detector input is less than 135 MHz.

## Virtex-6 CXT Device Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in Table 58. Values are expressed in nanoseconds unless otherwise noted.

Table 58: Global Clock Input to Output Delay Without MMCM

| Symbol                                                                                                         | Description                                      | Device     | Speed Grade |      | Units |
|----------------------------------------------------------------------------------------------------------------|--------------------------------------------------|------------|-------------|------|-------|
|                                                                                                                |                                                  |            | -2          | -1   |       |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>without</i> MMCM. |                                                  |            |             |      |       |
| T <sub>ICKOF</sub>                                                                                             | Global Clock input and OUTFF <i>without</i> MMCM | XC6VCX75T  | 5.88        | 5.88 | ns    |
|                                                                                                                |                                                  | XC6VCX130T | 6.00        | 6.00 | ns    |
|                                                                                                                |                                                  | XC6VCX195T | 6.13        | 6.13 | ns    |
|                                                                                                                |                                                  | XC6VCX240T | 6.13        | 6.13 | ns    |

### Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

Table 59: Global Clock Input to Output Delay With MMCM

| Symbol                                                                                                      | Description                                   | Device     | Speed Grade |      | Units |
|-------------------------------------------------------------------------------------------------------------|-----------------------------------------------|------------|-------------|------|-------|
|                                                                                                             |                                               |            | -2          | -1   |       |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> MMCM. |                                               |            |             |      |       |
| T <sub>ICKOFMMCMGC</sub>                                                                                    | Global Clock Input and OUTFF <i>with</i> MMCM | XC6VCX75T  | 2.77        | 2.77 | ns    |
|                                                                                                             |                                               | XC6VCX130T | 2.78        | 2.78 | ns    |
|                                                                                                             |                                               | XC6VCX195T | 2.78        | 2.78 | ns    |
|                                                                                                             |                                               | XC6VCX240T | 2.79        | 2.79 | ns    |

### Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. MMCM output jitter is already included in the timing calculation.

Table 60: Clock-Capable Clock Input to Output Delay With MMCM

| Symbol                                                                                                             | Description                                          | Device     | Speed Grade |      | Units |
|--------------------------------------------------------------------------------------------------------------------|------------------------------------------------------|------------|-------------|------|-------|
|                                                                                                                    |                                                      |            | -2          | -1   |       |
| LVCMOS25 Clock-capable Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> MMCM. |                                                      |            |             |      |       |
| T <sub>ICKOFMMCMCC</sub>                                                                                           | Clock-capable Clock Input and OUTFF <i>with</i> MMCM | XC6VCX75T  | 2.63        | 2.63 | ns    |
|                                                                                                                    |                                                      | XC6VCX130T | 2.65        | 2.65 | ns    |
|                                                                                                                    |                                                      | XC6VCX195T | 2.65        | 2.65 | ns    |
|                                                                                                                    |                                                      | XC6VCX240T | 2.65        | 2.65 | ns    |

### Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. MMCM output jitter is already included in the timing calculation.

## Virtex-6 CXT Device Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in Table 61. Values are expressed in nanoseconds unless otherwise noted.

Table 61: Global Clock Input Setup and Hold Without MMCM

| Symbol                                                                                                | Description                                                                                       | Device     | Speed Grade |            | Units |
|-------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|------------|-------------|------------|-------|
|                                                                                                       |                                                                                                   |            | -2          | -1         |       |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard. <sup>(1)</sup> |                                                                                                   |            |             |            |       |
| T <sub>PSFD</sub> / T <sub>PHFD</sub>                                                                 | Full Delay (Legacy Delay or Default Delay) Global Clock Input and IFF <sup>(2)</sup> without MMCM | XC6VCX75T  | 1.75/−0.01  | 1.75/−0.01 | ns    |
|                                                                                                       |                                                                                                   | XC6VCX130T | 1.88/−0.11  | 1.88/−0.11 | ns    |
|                                                                                                       |                                                                                                   | XC6VCX195T | 1.97/−0.14  | 1.97/−0.14 | ns    |
|                                                                                                       |                                                                                                   | XC6VCX240T | 1.97/−0.14  | 1.97/−0.14 | ns    |

### Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. IFF = Input Flip-Flop or Latch.
3. A Zero "0" Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed "best-case", but if a "0" is listed, there is no positive hold time.

Table 62: Global Clock Input Setup and Hold With MMCM

| Symbol                                                                                                | Description                                                  | Device     | Speed Grade |            | Units |
|-------------------------------------------------------------------------------------------------------|--------------------------------------------------------------|------------|-------------|------------|-------|
|                                                                                                       |                                                              |            | -2          | -1         |       |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard. <sup>(1)</sup> |                                                              |            |             |            |       |
| T <sub>PSMMCMGC</sub> /<br>T <sub>PHMMCMGC</sub>                                                      | No Delay Global Clock Input and IFF <sup>(2)</sup> with MMCM | XC6VCX75T  | 1.72/–0.22  | 1.72/–0.22 | ns    |
|                                                                                                       |                                                              | XC6VCX130T | 1.81/–0.21  | 1.81/–0.21 | ns    |
|                                                                                                       |                                                              | XC6VCX195T | 1.82/–0.20  | 1.82/–0.20 | ns    |
|                                                                                                       |                                                              | XC6VCX240T | 1.82/–0.20  | 1.82/–0.20 | ns    |

### Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. IFF = Input Flip-Flop or Latch.
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 63: Clock-Capable Clock Input Setup and Hold With MMCM

| Symbol                                                                                                       | Description                                                         | Device     | Speed Grade |            | Units |
|--------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------|------------|-------------|------------|-------|
|                                                                                                              |                                                                     |            | -2          | -1         |       |
| Input Setup and Hold Time Relative to Clock-capable Clock Input Signal for LVCMOS25 Standard. <sup>(1)</sup> |                                                                     |            |             |            |       |
| T <sub>PSMMCMCC</sub> /<br>T <sub>PHMMCMCC</sub>                                                             | No Delay Clock-capable Clock Input and IFF <sup>(2)</sup> with MMCM | XC6VCX75T  | 1.86/−0.28  | 1.86/−0.28 | ns    |
|                                                                                                              |                                                                     | XC6VCX130T | 1.93/−0.28  | 1.93/−0.28 | ns    |
|                                                                                                              |                                                                     | XC6VCX195T | 1.96/−0.27  | 1.96/−0.27 | ns    |
|                                                                                                              |                                                                     | XC6VCX240T | 1.96/−0.27  | 1.96/−0.27 | ns    |

### Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. IFF = Input Flip-Flop or Latch.
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.



## Clock Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Virtex-6 CXT FPGA clock transmitter and receiver data-valid windows.

Table 64: Duty Cycle Distortion and Clock-Tree Skew

| Symbol             | Description                                            | Device     | Speed Grade |      | Units |
|--------------------|--------------------------------------------------------|------------|-------------|------|-------|
|                    |                                                        |            | -2          | -1   |       |
| $T_{DCD\_CLK}$     | Global Clock Tree Duty Cycle Distortion <sup>(1)</sup> | All        | 0.12        | 0.12 | ns    |
| $T_{CKSKEW}$       | Global Clock Tree Skew <sup>(2)</sup>                  | XC6VCX75T  | 0.18        | 0.18 | ns    |
|                    |                                                        | XC6VCX130T | 0.29        | 0.29 | ns    |
|                    |                                                        | XC6VCX195T | 0.31        | 0.31 | ns    |
|                    |                                                        | XC6VCX240T | 0.31        | 0.31 | ns    |
| $T_{DCD\_BUFIO}$   | I/O clock tree duty cycle distortion                   | All        | 0.08        | 0.08 | ns    |
| $T_{BUFIO\_SKEW}$  | I/O clock tree skew across one clock region            | All        | 0.03        | 0.03 | ns    |
| $T_{BUFIO\_SKEW2}$ | I/O clock tree skew across three clock regions         | All        | 0.22        | 0.22 | ns    |
| $T_{DCD\_BUFR}$    | Regional clock tree duty cycle distortion              | All        | 0.15        | 0.15 | ns    |

### Notes:

- These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
- The  $T_{CKSKEW}$  value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA\_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.

Table 65: Package Skew

| Symbol        | Description                 | Device     | Package | Value | Units |
|---------------|-----------------------------|------------|---------|-------|-------|
| $T_{PKGSKEW}$ | Package Skew <sup>(1)</sup> | XC6VCX75T  | FF484   |       | ps    |
|               |                             |            | FF784   |       | ps    |
|               |                             | XC6VCX130T | FF484   | 95    | ps    |
|               |                             |            | FF784   | 146   | ps    |
|               |                             |            | FF1156  | 165   | ps    |
|               |                             | XC6VCX195T | FF784   |       | ps    |
|               |                             |            | FF1156  |       | ps    |
|               |                             | XC6VCX240T | FF784   | 146   | ps    |
|               |                             |            | FF1156  | 182   | ps    |

### Notes:

- These values represent the worst-case skew between any two SelectIO resources in the package: shortest flight time to longest flight time from Pad to Ball (7.0 ps per mm).
- Package trace length information is available for these device/package combinations. This information can be used to deskew the package.

Table 66: Sample Window

| Symbol            | Description                                                | Device | Speed Grade |     | Units |
|-------------------|------------------------------------------------------------|--------|-------------|-----|-------|
|                   |                                                            |        | -2          | -1  |       |
| $T_{SAMP}$        | Sampling Error at Receiver Pins <sup>(1)</sup>             | All    | 610         | 610 | ps    |
| $T_{SAMP\_BUFIO}$ | Sampling Error at Receiver Pins using BUFIO <sup>(2)</sup> | All    | 400         | 400 | ps    |

**Notes:**

1. This parameter indicates the total sampling error of Virtex-6 CXT FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the MMCM to capture the DDR input registers' edges of operation. These measurements include:
  - CLK0 MMCM jitter
  - MMCM accuracy (phase offset)
  - MMCM phase shift resolution
 These measurements do not include package or clock tree skew.
2. This parameter indicates the total sampling error of Virtex-6 CXT FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the BUFIO clock network and IODELAY to capture the DDR input registers' edges of operation. These measurements do not include package or clock tree skew.

Table 67: Pin-to-Pin Setup/Hold and Clock-to-Out

| Symbol                                                                              | Description               | Speed Grade |            | Units |
|-------------------------------------------------------------------------------------|---------------------------|-------------|------------|-------|
|                                                                                     |                           | -2          | -1         |       |
| Data Input Setup and Hold Times Relative to a Forwarded Clock Input Pin Using BUFIO |                           |             |            |       |
| T <sub>PSCS</sub> /T <sub>PHCS</sub>                                                | Setup/Hold of I/O clock   | −0.33/1.31  | −0.33/1.31 | ns    |
| Pin-to-Pin Clock-to-Out Using BUFIO                                                 |                           |             |            |       |
| T <sub>ICKOFCS</sub>                                                                | Clock-to-Out of I/O clock | 5.19        | 5.19       | ns    |

## Revision History

The following table shows the revision history for this document:

| Date     | Version | Description of Revisions                                                                                                                                                                                                                        |
|----------|---------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 07/08/09 | 1.0     | Initial Xilinx release.                                                                                                                                                                                                                         |
| 02/05/10 | 1.1     | Removed Figure 11: Placement Diagram for the FF1156 Package (5 of 5) from page 11 as there are only 16 GTX transceivers in the FF1156 package. Corrected the placement diagrams in <a href="#">Figure 2</a> through <a href="#">Figure 10</a> . |

| Date     | Version | Description of Revisions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|----------|---------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 06/08/10 | 1.2     | <p>Revised <a href="#">GTX Transceivers in CXT Devices</a>, page 5.</p> <p>Added <math>V_{FS}</math> and revised the <math>V_{IN}</math> and <math>V_{TS}</math> values in <a href="#">Table 9</a>, page 11.</p> <p>Added <math>V_{FS}</math> and note 6 to <a href="#">Table 10</a>. Revised description of <math>C_{IN}</math> in <a href="#">Table 11</a>, including adding note 3.</p> <p>Updated <a href="#">Table 13</a> including adding note 2.</p> <p>Removed DIFF SSTL15 and added values to SSTL15 in <a href="#">Table 15</a>.</p> <p>Updated <a href="#">Table 16</a> through <a href="#">Table 19</a>.</p> <p>Added <a href="#">eFUSE Read Endurance</a> section.</p> <p>Updated entire <a href="#">GTX Transceivers in CXT Devices</a> section.</p> <p>Changed specifications of PCI Express in <a href="#">Table 34</a>.</p> <p>In <a href="#">Table 35</a>, removed RLDRAM II and revised and added values to other interface performance specifications.</p> <p>Updated speed specification to v1.04 with appropriate changes to <a href="#">Table 36</a>.</p> <p>Revised the IOB switching characteristics in <a href="#">Table 38</a>.</p> <p>Updated values in <a href="#">Table 39</a> and note 4 in <a href="#">Table 41</a>.</p> <p>ILOGIC (<a href="#">Table 42</a>), OLOGIC (<a href="#">Table 43</a>), ISERDES (<a href="#">Table 44</a>), and OSERDES (<a href="#">Table 45</a>) switching characteristics changes.</p> <p>Revised <math>T_{IDELAY\_CLK\_MAX}</math> and <math>T_{IDELAYPAT\_JIT}</math> in <a href="#">Table 46</a>.</p> <p>Revised CLB switching characteristics and added <math>T_{SHCKO}</math> to <a href="#">Table 47</a> and revised CLB switching characteristics in <a href="#">Table 48</a> and <a href="#">Table 49</a>.</p> <p>In <a href="#">Table 50</a>, removed <math>T_{RCKO\_RDCOUNT}</math> and <math>T_{RCKO\_WRCOUNT}</math>, removed <math>T_{RCKO\_PARITY\_ECC}</math>: Clock CLK to ECCPARITY in standard ECC mode, revised <math>T_{RDCK\_DI\_ECC}/T_{RCKD\_DI\_ECC}</math>, <math>T_{RCKO\_POINTERS}</math>, and revised <math>F_{MAX}</math> and <math>F_{MAX\_CASCADE}</math> switching characteristics.</p> <p>Multiple changes to configuration specifications in <a href="#">Table 52</a>.</p> <p>Revised switching characteristics and global clock tree (BUFG) <math>F_{MAX}</math> in <a href="#">Table 53</a>.</p> <p>Revised switching characteristics and I/O clock tree (BUFIO) <math>F_{MAX}</math> in <a href="#">Table 54</a>.</p> <p>Added note 1 to <a href="#">Table 55</a>.</p> <p>Revised the <math>F_{MAX}</math> horizontal clock tree (BUFH) in <a href="#">Table 56</a>.</p> <p>Multiple changes to MMCM specifications in <a href="#">Table 57</a> including <math>F_{INMAX}</math> and <math>F_{OUTMAX}</math>.</p> <p>Updated switching characteristics in <a href="#">Table 58</a> through <a href="#">Table 63</a>.</p> <p>Removed <math>T_{DCD\_BUFH}</math> and <math>T_{BUFH\_SKEW}</math> from <a href="#">Table 64</a>.</p> |
| 06/30/10 | 1.3     | <p>Production release of XC6VCX130T and XC6VCX240T in <a href="#">Table 36</a> and <a href="#">Table 37</a>. Updated -1 speed grade SDR values in <a href="#">Table 35</a>. Updated BUFIO <math>F_{MAX}</math> specification in <a href="#">Table 54</a>. Added Note 6 to <a href="#">Table 57</a>.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 07/28/10 | 1.4     | <p>Production release of XC6VCX75T and XC6VCX195T in <a href="#">Table 36</a> and <a href="#">Table 37</a> using ISE 12.2 software with speed file v1.06 using the <i>Speed File Patch</i>. Updated PCI compliance on page 1. Added values to <a href="#">Table 13</a>. In <a href="#">Table 25</a>, update <math>V_{CMOUTDC}</math> equation to <math>MGTA VTT - DV_{PPOUT}/4</math>. Updated <math>F_{MAX}</math> in <a href="#">Table 53</a>, <a href="#">Table 54</a>, and <a href="#">Table 56</a>. Updated <math>F_{INMAX}</math> and <math>F_{OUTMAX}</math> in <a href="#">Table 57</a>. Updated values in <a href="#">Table 61</a>, <a href="#">Table 62</a>, and <a href="#">Table 63</a>.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 10/14/10 | 1.5     | <p>Moved data sheet to Production status on the first page. Updated speed file with ISE 12.3 software with speed file v1.08 using the <i>Speed File Patch</i>. In <a href="#">Table 51</a>, updated values for <math>T_{DSPCKO\_PCOUT}</math>, <math>CARRYCASCOUT</math>, <math>MULTSIGNOUT\_PREG</math>.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 02/11/11 | 1.6     | <p>Updated <a href="#">Table 10</a> to include the industrial range specifications. Added Note 12 to <a href="#">Table 50</a>. Revised <math>T_{BPICCO}</math> values in <a href="#">Table 52</a>. Updated range description for <math>F_{INDUTY}</math> in <a href="#">Table 57</a> and added note 8.</p> <p>The following revisions are due to specification changes as described in <a href="#">XCN11009</a>, <i>Virtex-6 FPGA: Data Sheet, User Guides, and JTAG ID Updates</i>.</p> <p>In <a href="#">Table 52</a>, updated the values for <math>T_{SMCKW}</math>, <math>T_{SPIDCC}</math>, <math>T_{SPICCM}</math>, and <math>T_{SPICFC}</math>. In <a href="#">Table 57: MMCM Specification</a>, added bandwidth settings to <math>F_{PFDMIN}</math> and added note 1.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

## Notice of Disclaimer

THE XILINX HARDWARE FPGA AND CPLD DEVICES REFERRED TO HEREIN ("PRODUCTS") ARE SUBJECT TO THE TERMS AND CONDITIONS OF THE XILINX LIMITED WARRANTY WHICH CAN BE VIEWED AT <http://www.xilinx.com/warranty.htm>. THIS LIMITED WARRANTY DOES NOT EXTEND TO ANY USE OF PRODUCTS IN AN APPLICATION OR ENVIRONMENT THAT IS NOT WITHIN THE SPECIFICATIONS STATED IN THE XILINX DATA SHEET. ALL SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE. PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS LIFE-SUPPORT OR SAFETY DEVICES OR SYSTEMS, OR ANY OTHER APPLICATION THAT INVOKES THE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). USE OF PRODUCTS IN CRITICAL APPLICATIONS IS AT THE SOLE RISK OF CUSTOMER, SUBJECT TO APPLICABLE LAWS AND REGULATIONS.

### CRITICAL APPLICATIONS DISCLAIMER

XILINX PRODUCTS (INCLUDING HARDWARE, SOFTWARE AND/OR IP CORES) ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE, OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS IN LIFE-SUPPORT OR SAFETY DEVICES OR SYSTEMS, CLASS III MEDICAL DEVICES, NUCLEAR FACILITIES, APPLICATIONS RELATED TO THE DEPLOYMENT OF AIRBAGS, OR ANY OTHER APPLICATIONS THAT COULD LEAD TO DEATH, PERSONAL INJURY OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE (INDIVIDUALLY AND COLLECTIVELY, "CRITICAL APPLICATIONS"). FURTHERMORE, XILINX PRODUCTS ARE NOT DESIGNED OR INTENDED FOR USE IN ANY APPLICATIONS THAT AFFECT CONTROL OF A VEHICLE OR AIRCRAFT, UNLESS THERE IS A FAIL-SAFE OR REDUNDANCY FEATURE (WHICH DOES NOT INCLUDE USE OF SOFTWARE IN THE XILINX DEVICE TO IMPLEMENT THE REDUNDANCY) AND A WARNING SIGNAL UPON FAILURE TO THE OPERATOR. CUSTOMER AGREES, PRIOR TO USING OR DISTRIBUTING ANY SYSTEMS THAT INCORPORATE XILINX PRODUCTS, TO THOROUGHLY TEST THE SAME FOR SAFETY PURPOSES. TO THE MAXIMUM EXTENT PERMITTED BY APPLICABLE LAW, CUSTOMER ASSUMES THE SOLE RISK AND LIABILITY OF ANY USE OF XILINX PRODUCTS IN CRITICAL APPLICATIONS.

### AUTOMOTIVE APPLICATIONS DISCLAIMER

XILINX PRODUCTS ARE NOT DESIGNED OR INTENDED TO BE FAIL-SAFE, OR FOR USE IN ANY APPLICATION REQUIRING FAIL-SAFE PERFORMANCE, SUCH AS APPLICATIONS RELATED TO: (I) THE DEPLOYMENT OF AIRBAGS, (II) CONTROL OF A VEHICLE, UNLESS THERE IS A FAIL-SAFE OR REDUNDANCY FEATURE (WHICH DOES NOT INCLUDE USE OF SOFTWARE IN THE XILINX DEVICE TO IMPLEMENT THE REDUNDANCY) AND A WARNING SIGNAL UPON FAILURE TO THE OPERATOR, OR (III) USES THAT COULD LEAD TO DEATH OR PERSONAL INJURY. CUSTOMER ASSUMES THE SOLE RISK AND LIABILITY OF ANY USE OF XILINX PRODUCTS IN SUCH APPLICATIONS.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.